

Status and Performance of the MIMOSIS CMOS Sensor for the Micro-Vertex Detector of CBM Experiment

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For the CBM-MVD collaboration

VERTEX 2025

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<https://indico.phy.ornl.gov/event/677/>

Supported by:



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Bundesministerium
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und Raumfahrt
(05P19RFFC1)

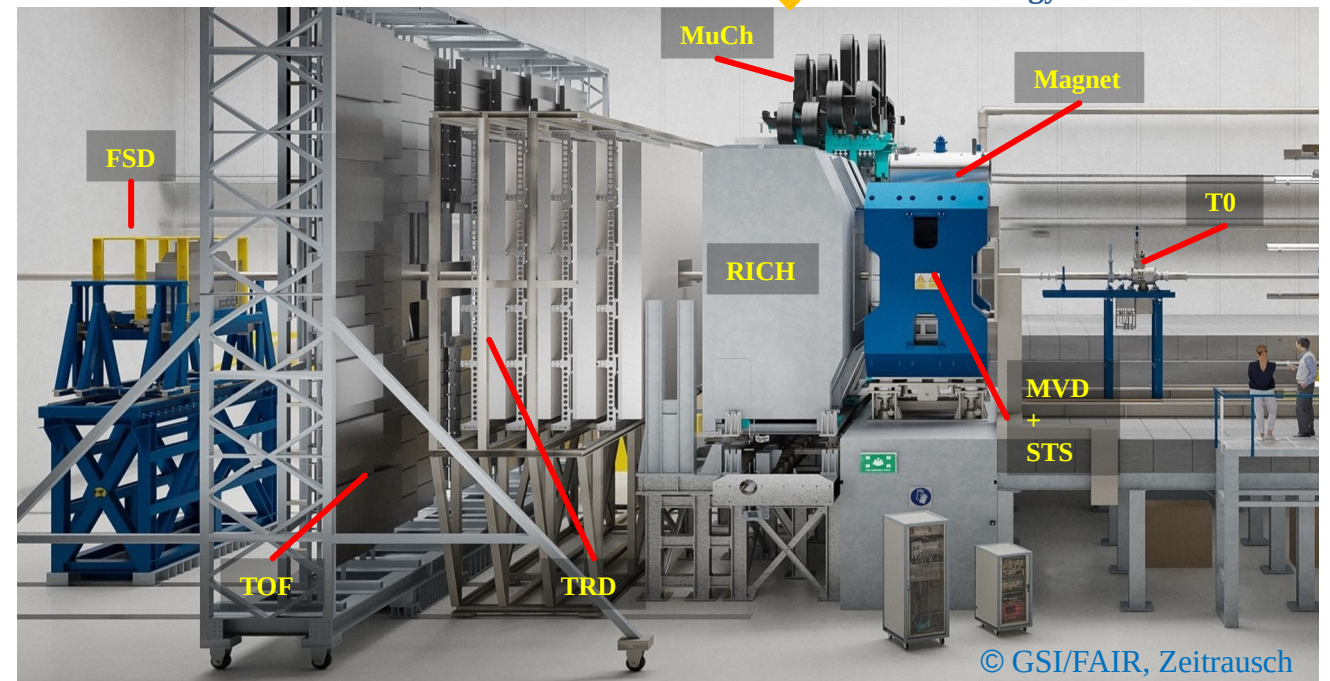
- Introduction to CBM experiment
- Overview of CBM-MVD
- MIMOSIS sensors for MVD
- System integration
- Testing sensors in the mini-CBM experiment
- Summary



- Fixed target heavy ion experiment
- Explore properties of nuclear matter at **high net baryon density** and understanding the **Equation of State (EoS)**
- Investigate **rare probes**:
 - Multi-strange hyperons, hypernuclei, dileptons
 - Aiming to identify signature of first order phase transition
- Goal is to measure precisely **low- and high-momentum tracks** in high **multiplicity** and radiation environment
- To achieve this:
 - **High interaction rates**
 - CBM employs free-streaming, self-triggered readout
 - **Radiation hard detectors** and components

T0: Time Zero and Beam Diagnostic
 STS: Silicon Tracking System
 RICH: Ring Imaging Cherenkov Detector
 TOF: Time of Flight

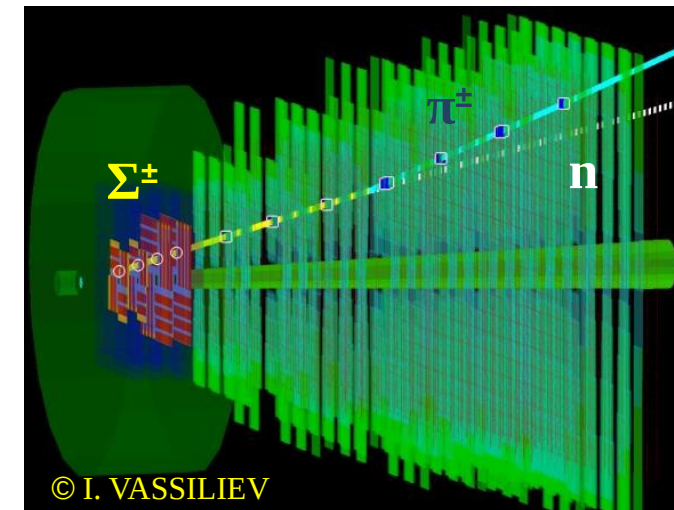
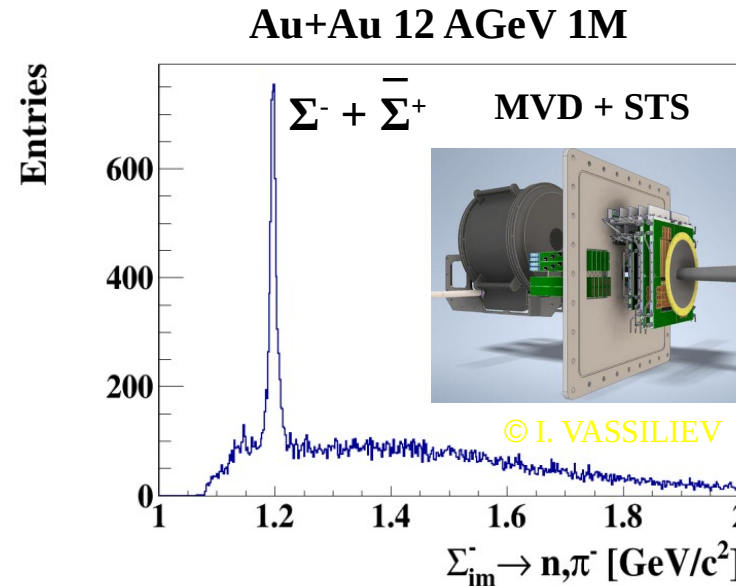
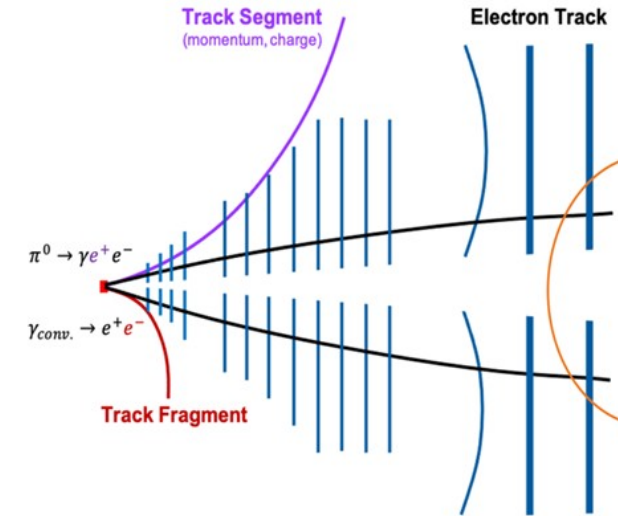
MVD: **Micro-Vertex Detector**
 MuCh: Muon Chamber
 TRD: Transition Radiation Detector
 FSD: Forward Spectator Detector



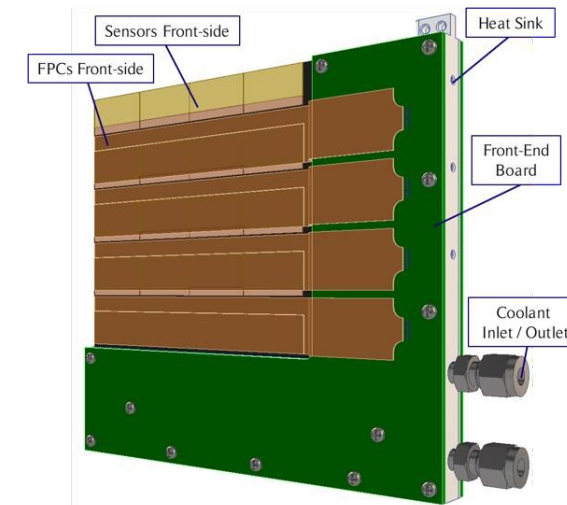
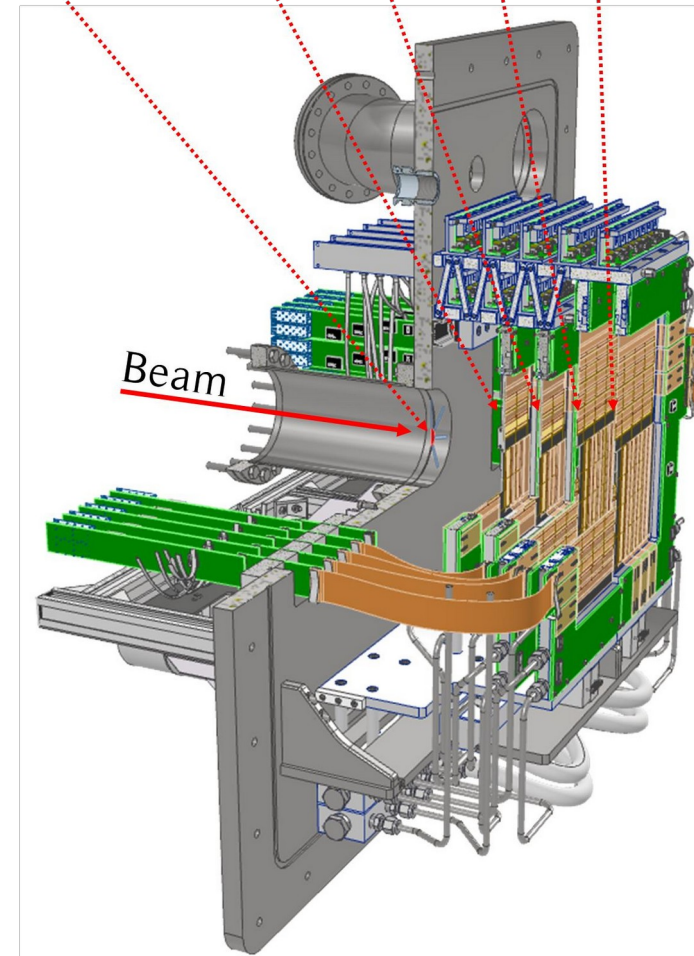
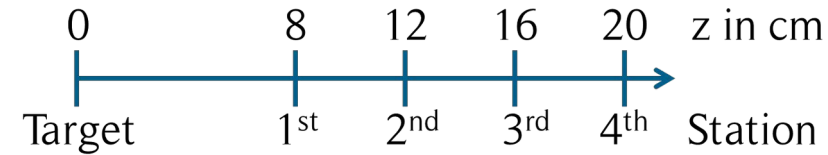
Schematics of the CBM experimental setup with its subdetectors ([arXiv:2506.20545](https://arxiv.org/abs/2506.20545))

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- Key component of CBM tracking system
- Precise reconstruction of secondary decay vertices
- Suppression of combinatorial background (di-electron)
 - Conversion
 - π^0 Dalitz pairs
- Reconstruction of short lived particles
 - Λ , Ξ , and open charm hadrons
- Low momentum tracking
- ◆ together with STS
 - enables reconstruction of Σ baryons (which decay with neutral daughter)



- ◆ Four planar tracking stations
 - ~300 CMOS MAPS
 - Placed inside **vacuum, magnetic field**
 - 1 Tm magnetic field
- ◆ $\sigma = 5\mu\text{m}$ and $< 0.5\%$ X_0/layer
- ◆ 100 kHz — 10 AGeV Au+Au collisions
- ◆ 10 MHz — 30 GeV p+Au collisions
- ◆ Two detector geometries
 - **Tracking (8-20 cm) → Start Setup**
 - Vertexing (5-20 cm)



	Requirement
Spatial & Time Resolution	5 μm & 5 μs
Sensor thickness	$\sim 70 \mu\text{m}$ (50 μm EPI)
Power dissipation	$< 100 \text{ mW/cm}^2$
NIEL	$7 \times 10^{13} \text{ n}_{\text{eq}}/\text{cm}^2$
TID	$\sim 5 \text{ MRad}$
Radiation gradient over sensor	$\sim 100\%$
Heavy ion tolerance	1 kHz/cm^2
Rate (Average / 35 μs peak)	$20/80 \text{ MHz/cm}^2$

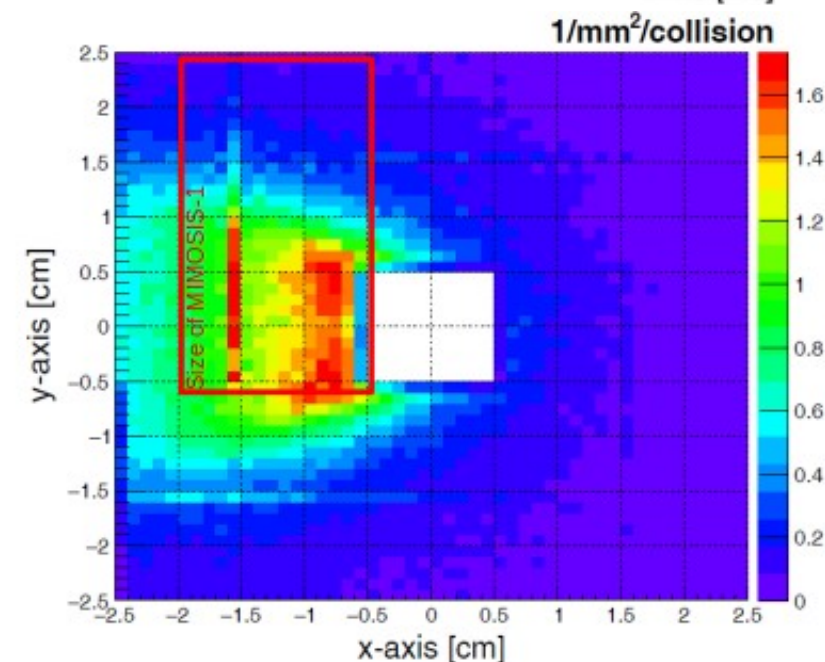
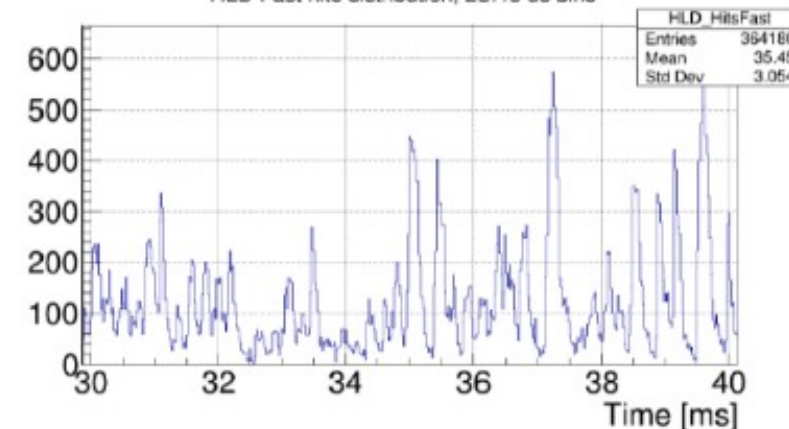
$\sim 10 \times \text{ALPIDE}$

$\sim 20 \times \text{ALPIDE}$

beam intensity fluctuations (SIS-18)

kHz modulation ON

HLD Fast hits distribution, 20.48 us bins



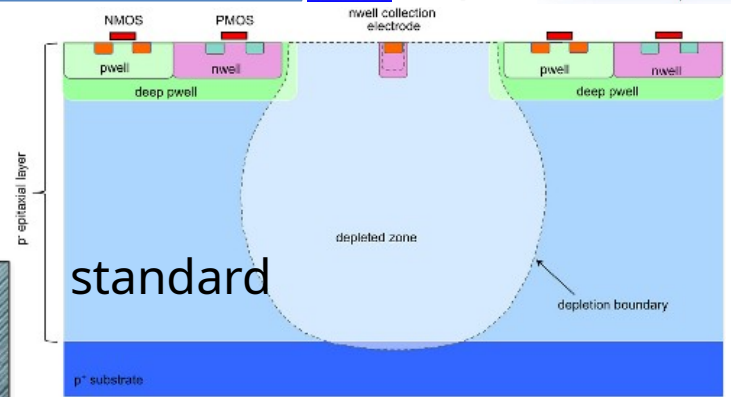
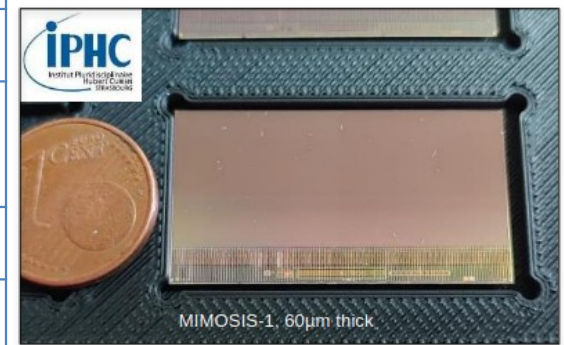
Customized sensor for CBM MVD: **MIMOSIS**

- Derived from ALPIDE (TJ 180 nm process)
- Fully depleted sensing node
- Re-designed digital front- and back-end (higher bandwidth, elastic buffer...)

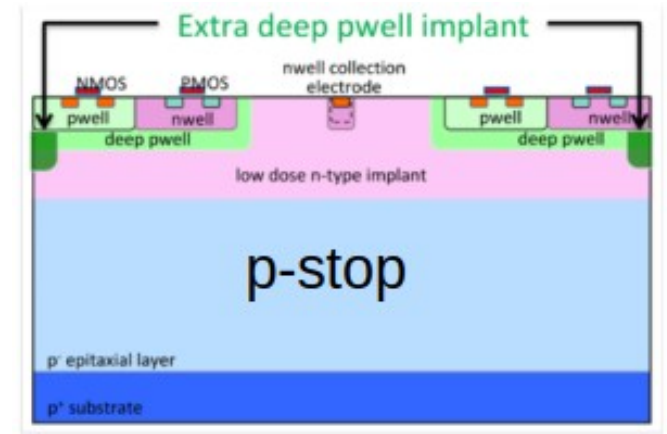
MIMOSIS for MVD

Technical features of MIMOSIS

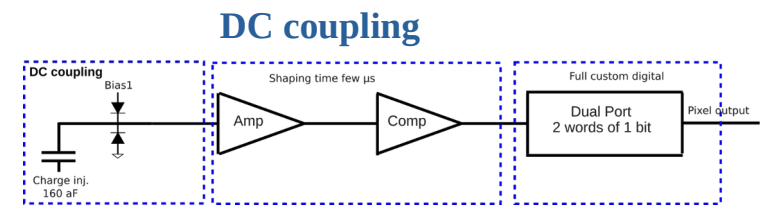
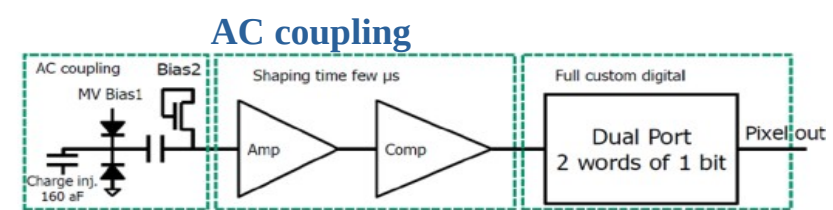
Category	Specification
Pixel Matrix	1024 × 504 pixels; ~30 μm × ~27 μm pitch
Active Area	≈ 31.15 × 17.25 mm ²
Epitaxial Layer options	25 μm and 50 μm
Sensing node	DC (ALPIDE-like) and AC pixels
Biasing	Back bias up to 6 V; top HV (AC pixels) up to 20 V
Frame	5 μs integration time
Output Bandwidth	Up to 8 × 320 Mb/s differential links (switchable)
Power density	< 100 mW/cm ²
Special Features	On-matrix pixel grouping

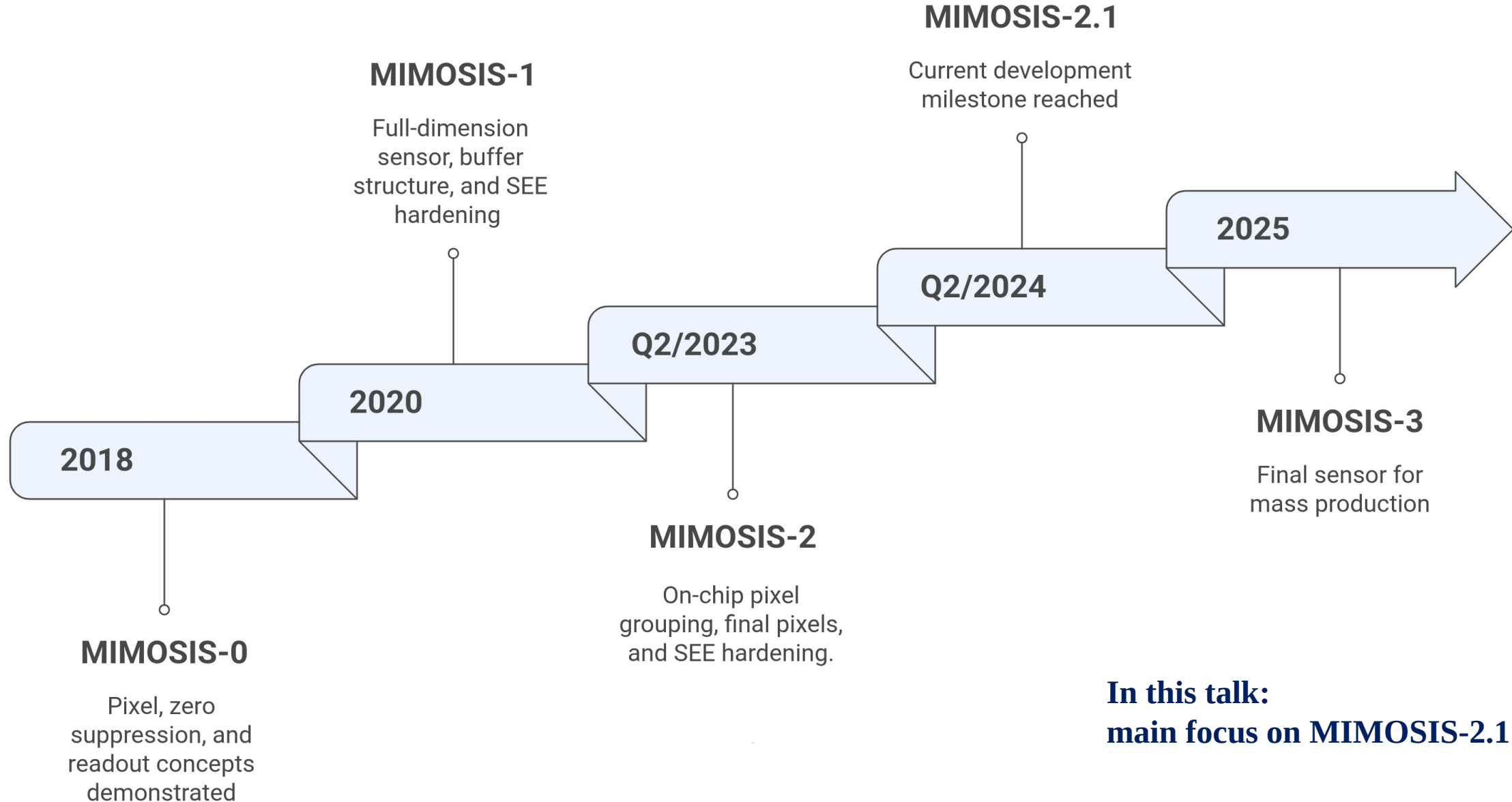


Known from ALICE/ALPIDE
 + Radiation hardness
 - Spat. Resolution



H. Pernegger et al., 2017 JINST 12 P06008





**In this talk:
main focus on MIMOSIS-2.1**

MIMOSIS - beam telescope:

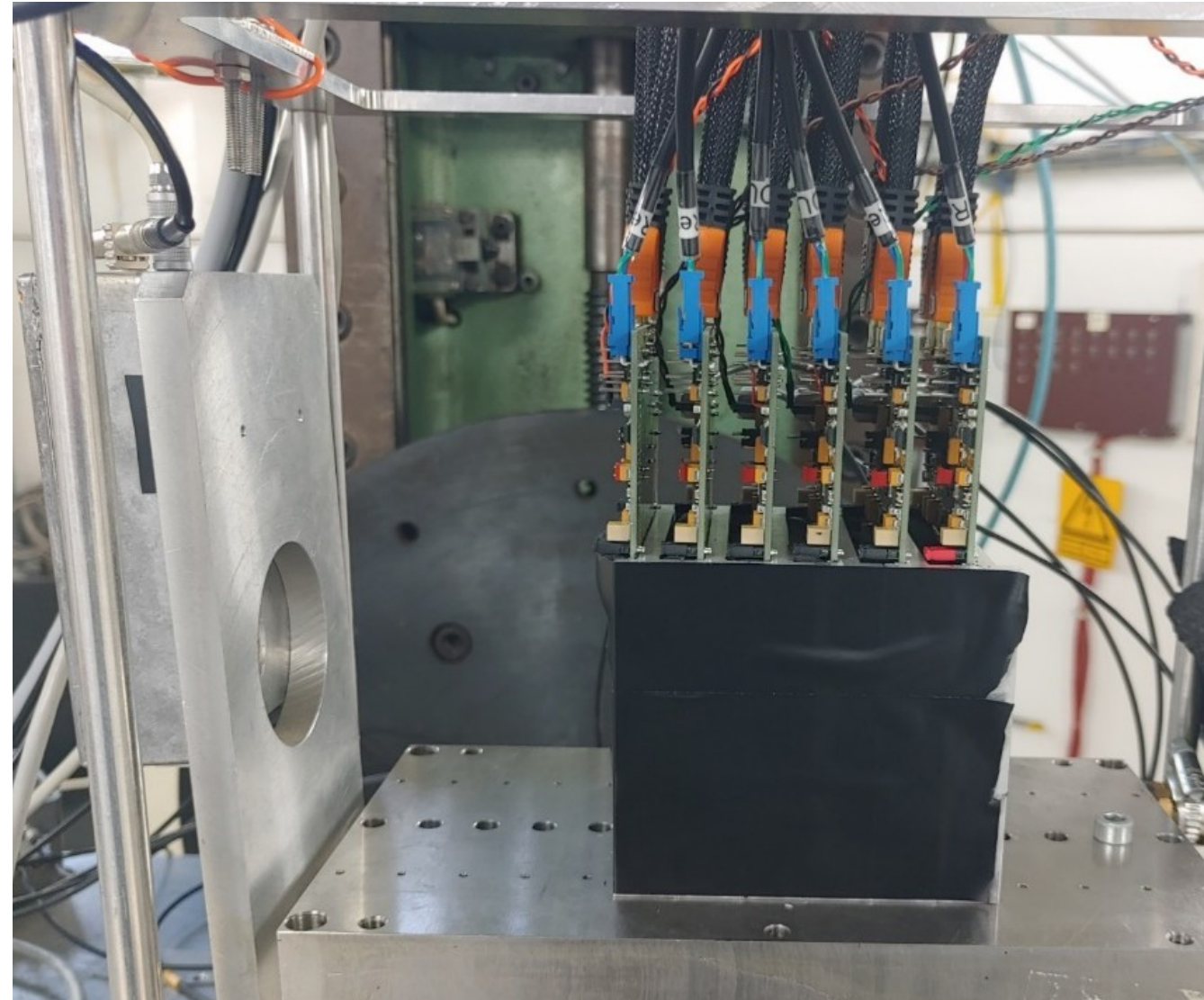
- 6 MIMOSIS-1 or 2.1 sensors
- 4 reference sensors (standard epi-layer)
- 2 devices under test
- Reference Track Uncertainty:
 - $2.5 \mu\text{m} + 1.5 \mu\text{m}$ multiple scattering (DESY only)

Irradiation:

- 1 MeV reactor neutrons (TRIGA, Ljubjana).
- Few 10 keV X-rays (KIT)
- Storage at room temperature.

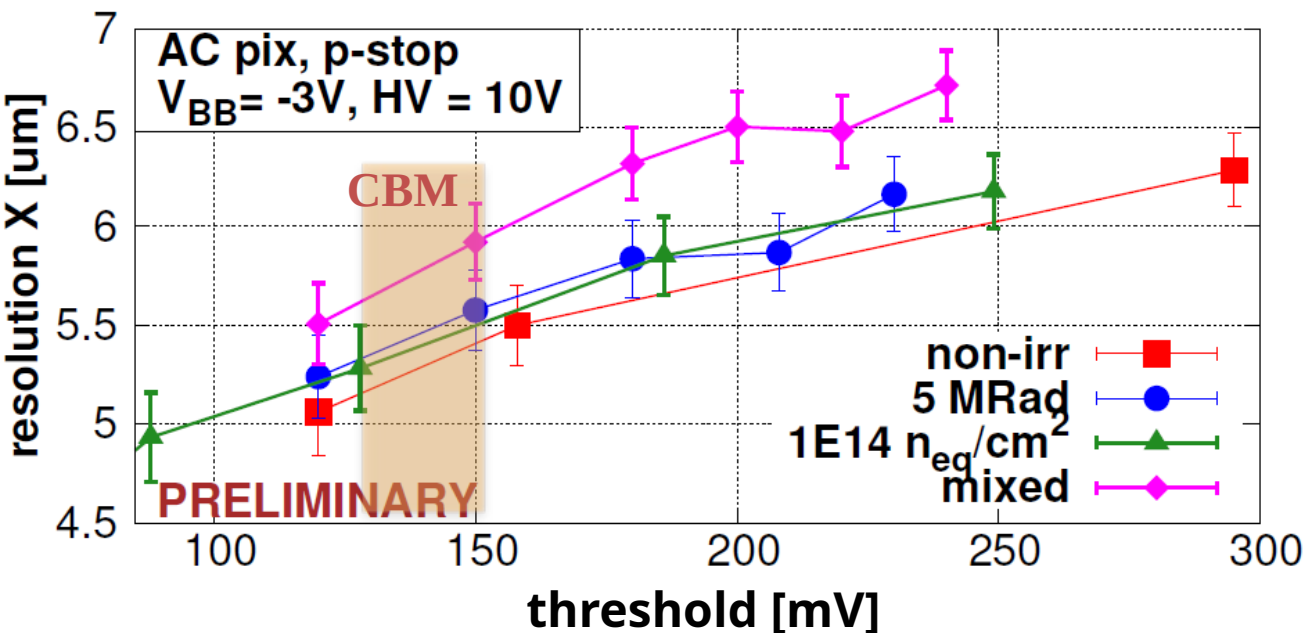
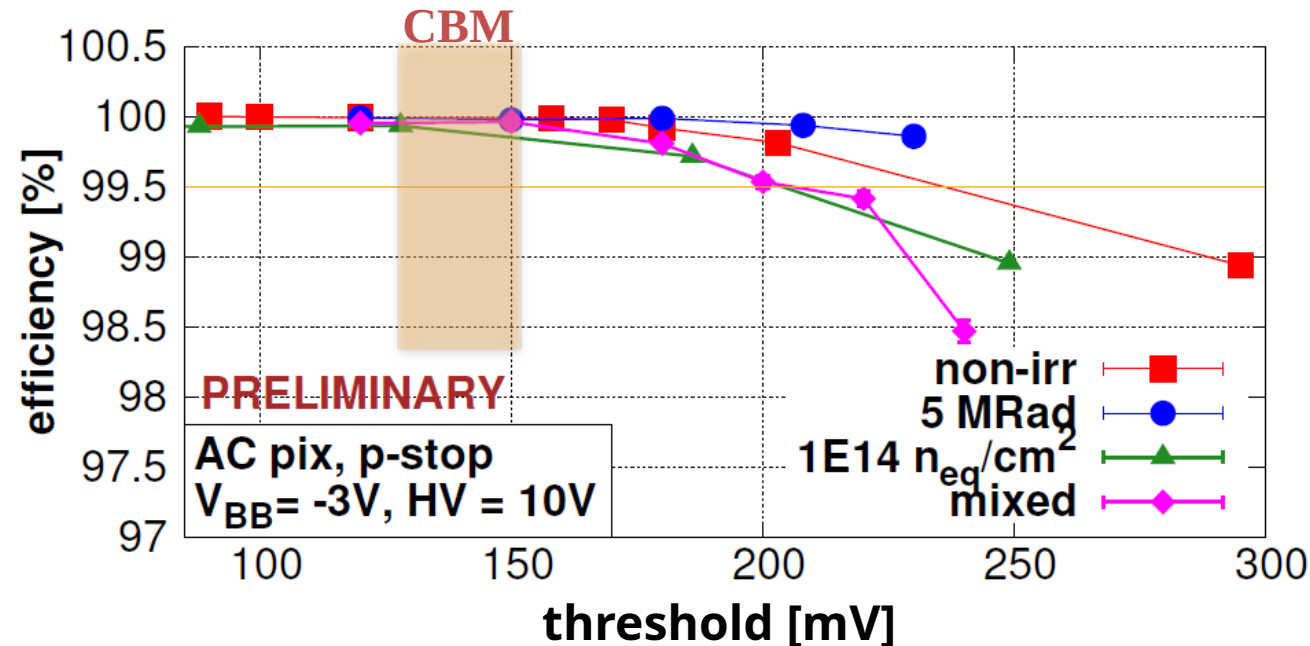
Beam test:

- 5 GeV e- Beam @ DESY
- 120 GeV Pion Beam @SPS-CERN
- ~ 1 GeV d – beam @ COSY
(Stabilized room temperature)



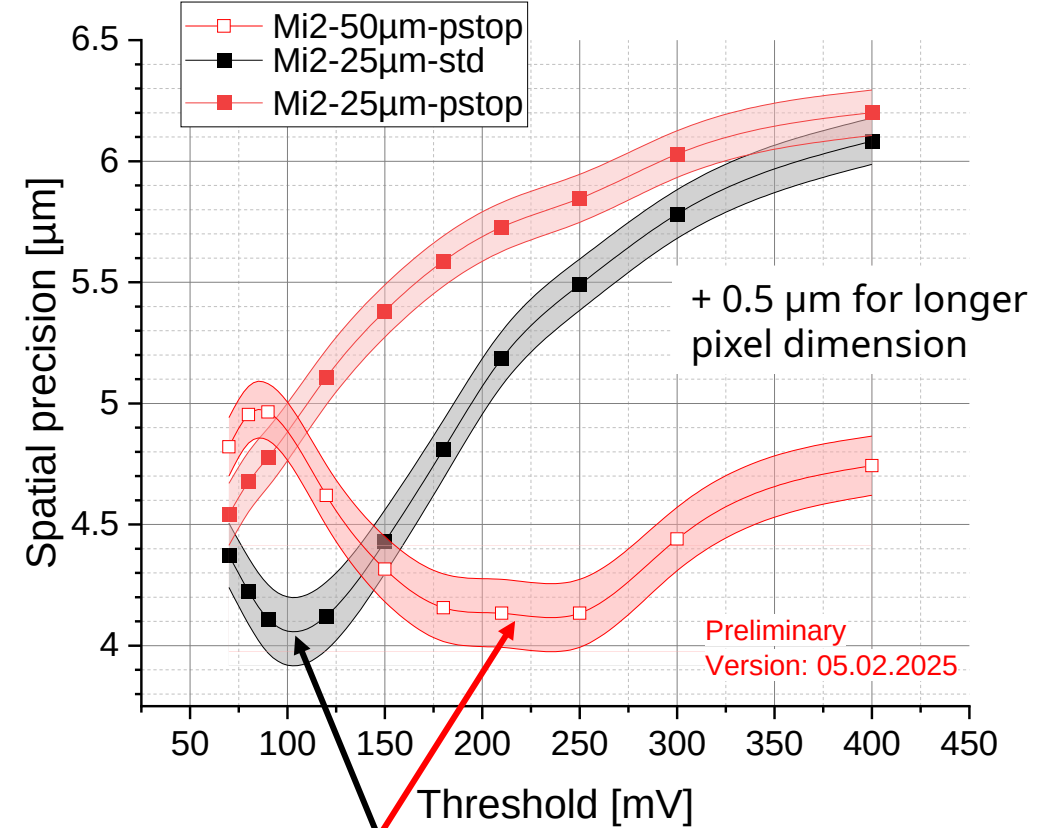
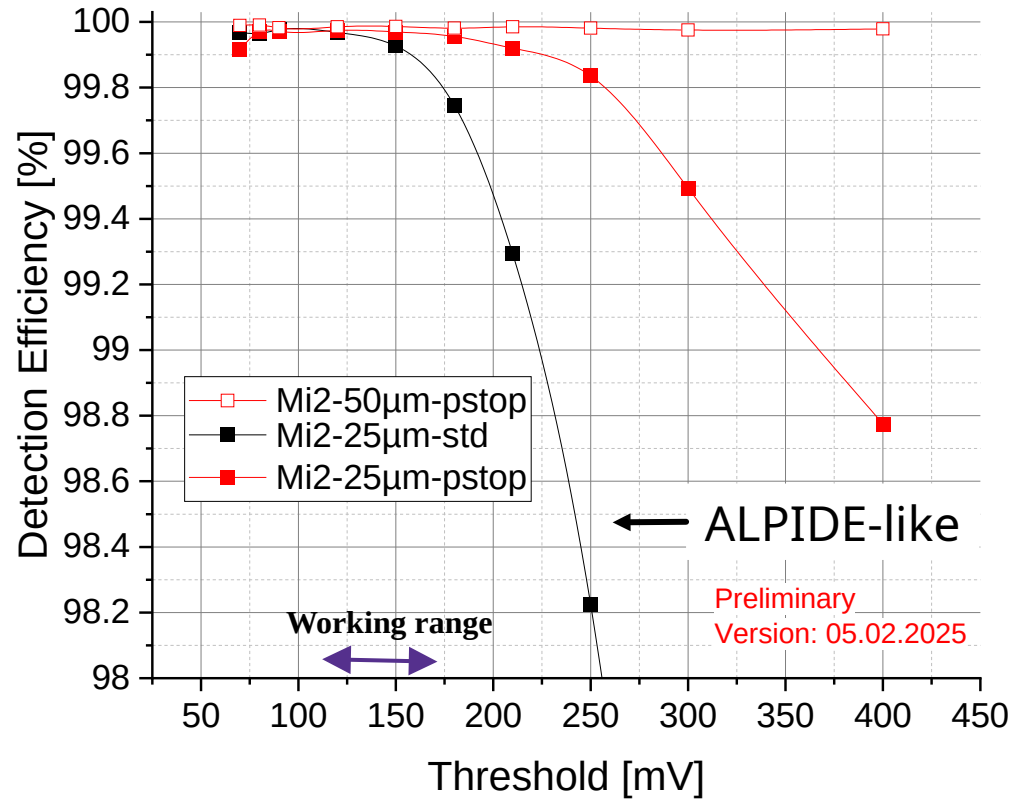
Before and after irradiation

- Best performance: AC P-stop
- Efficiency > 99% (end of lifetime)
- Dark rate:
 - Marginal before irradiation
 - $< 10^{-6}$ after irradiation



Conclusion:

- All pixels work excellently before irradiation
- STD pixels show better spatial resolution
- P-stop AC pixel: most radiation hard — matches CBM requirements

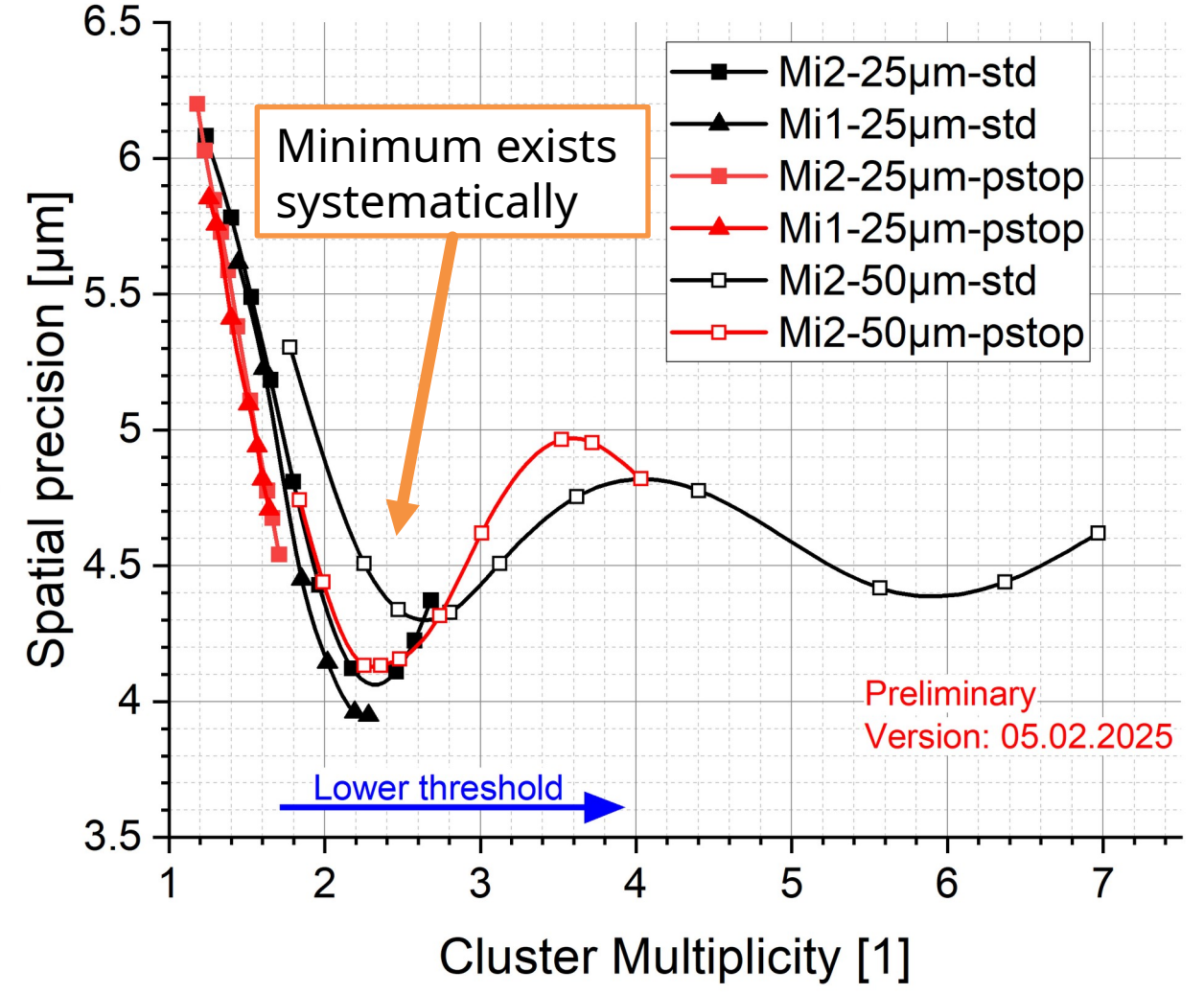
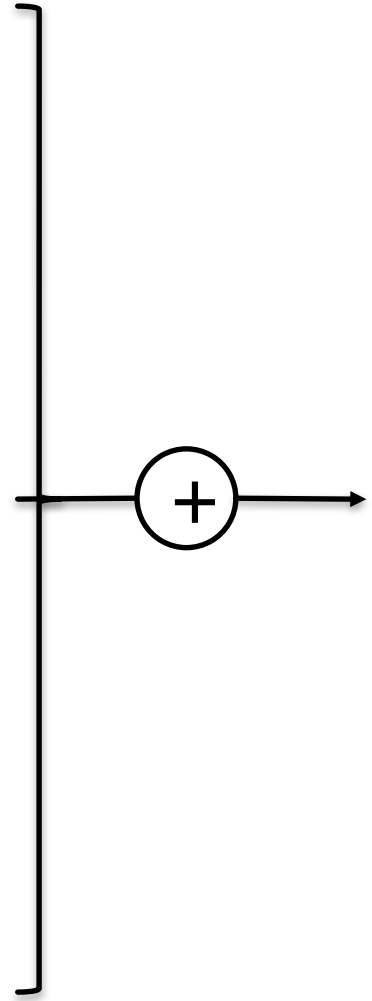
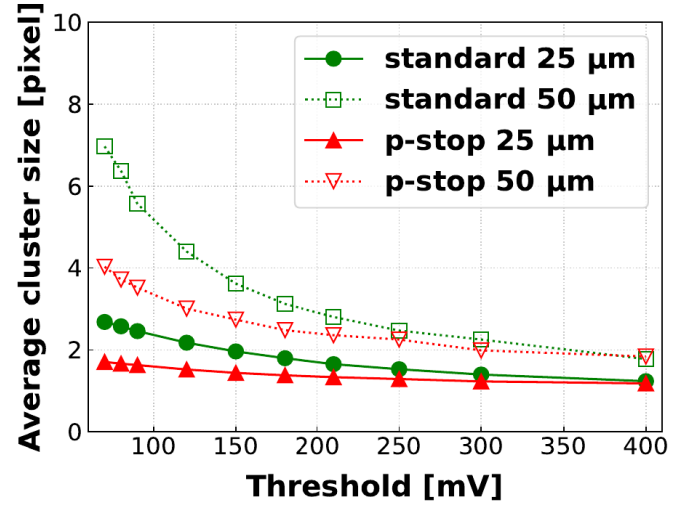
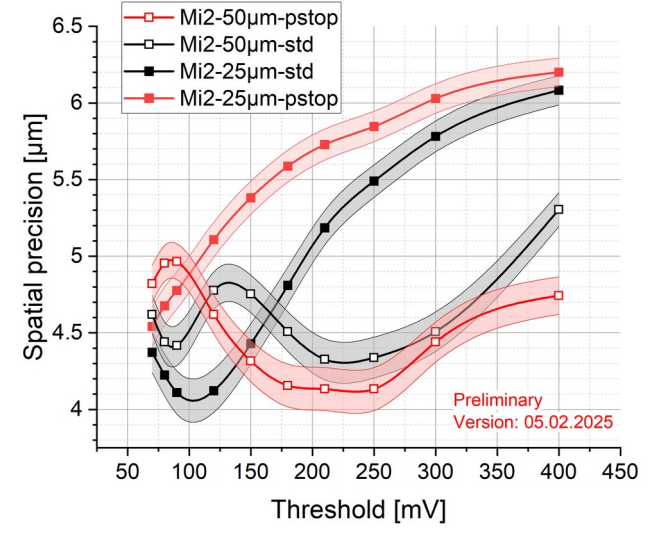


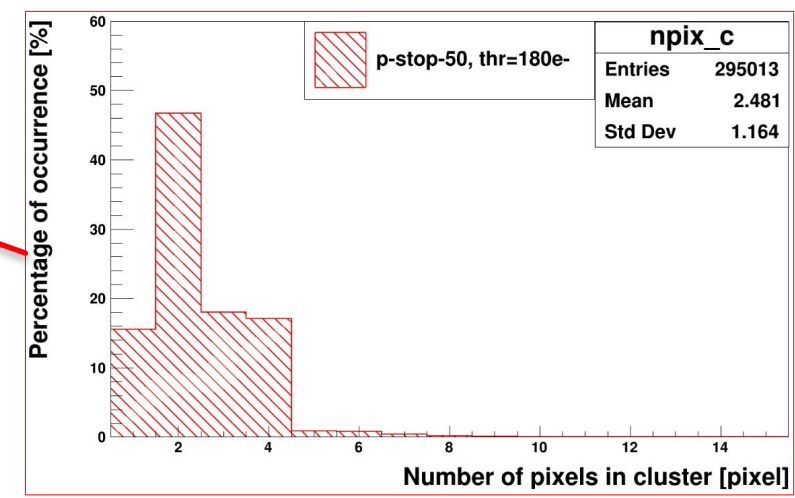
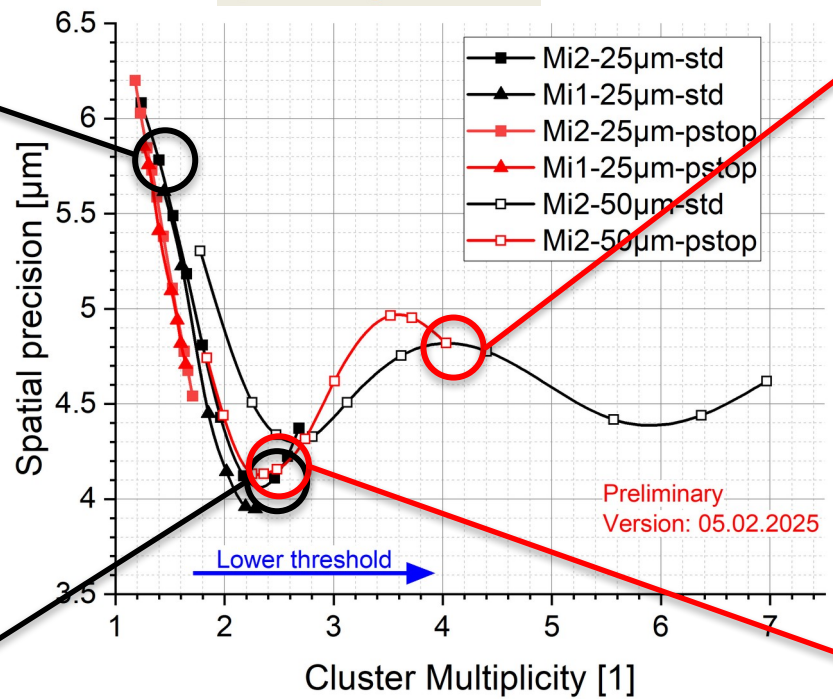
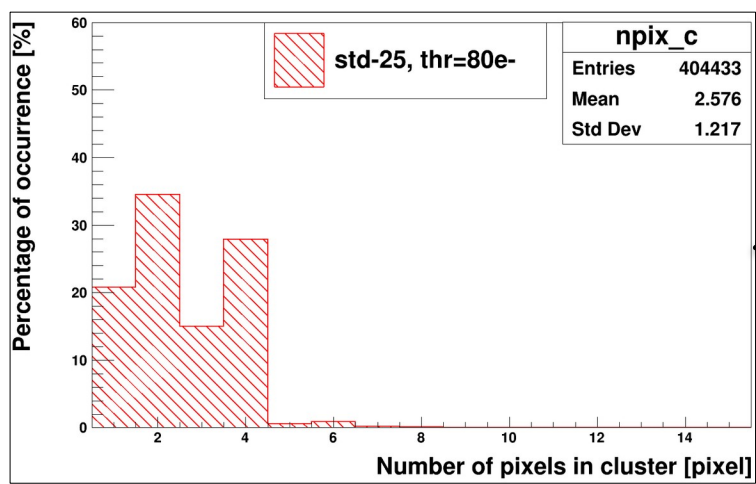
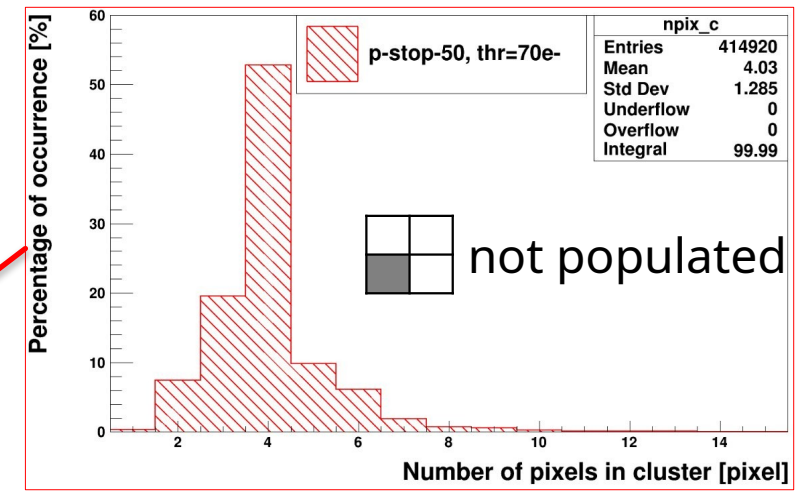
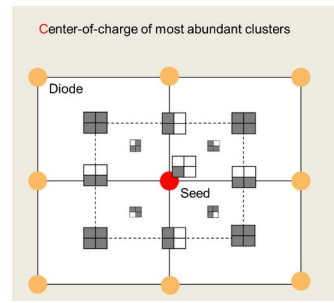
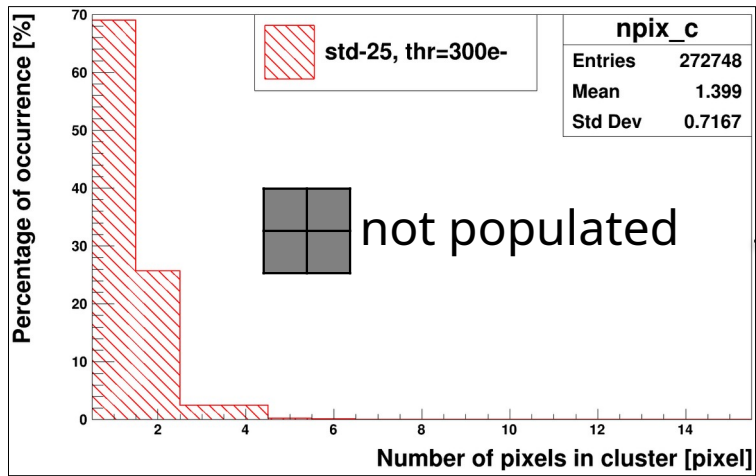
Optimal number of fired pixels/particle (about 2.5)

Dark rate typically $<10^{-10}$ /pixel (2 Hz/cm^2) driven by individual hot pixels.

P-stop 50 μm shows superior working range and spat. precision w.r.t p-stop 25 μm .

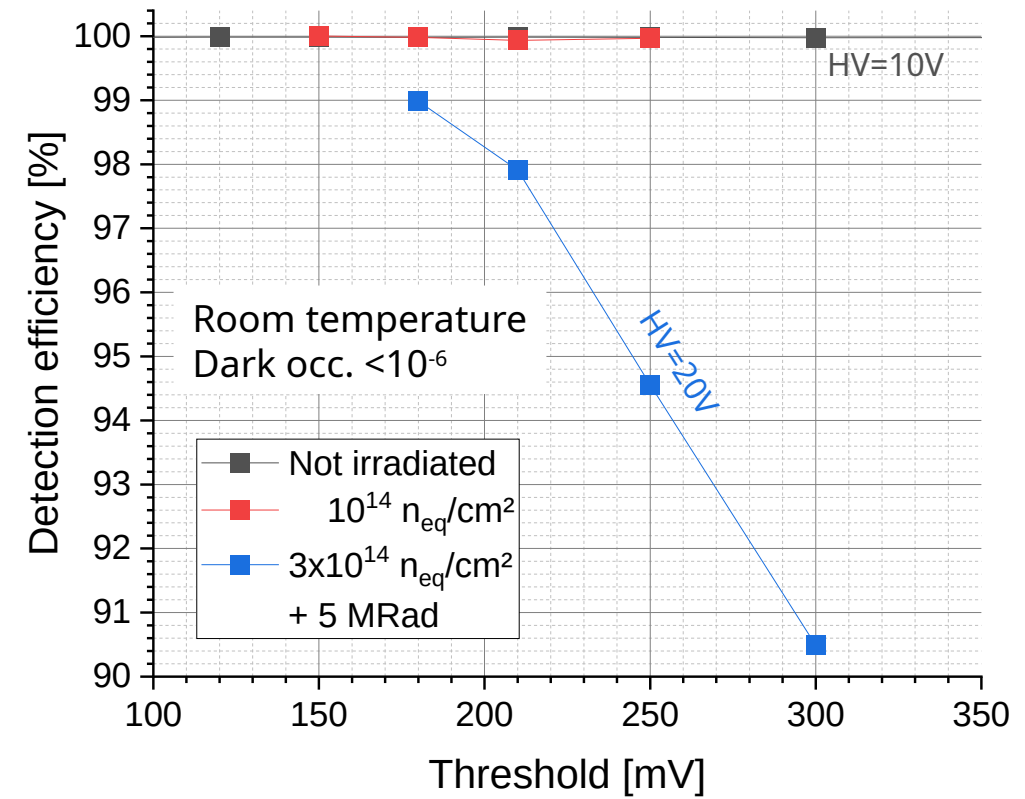
AC-pixel



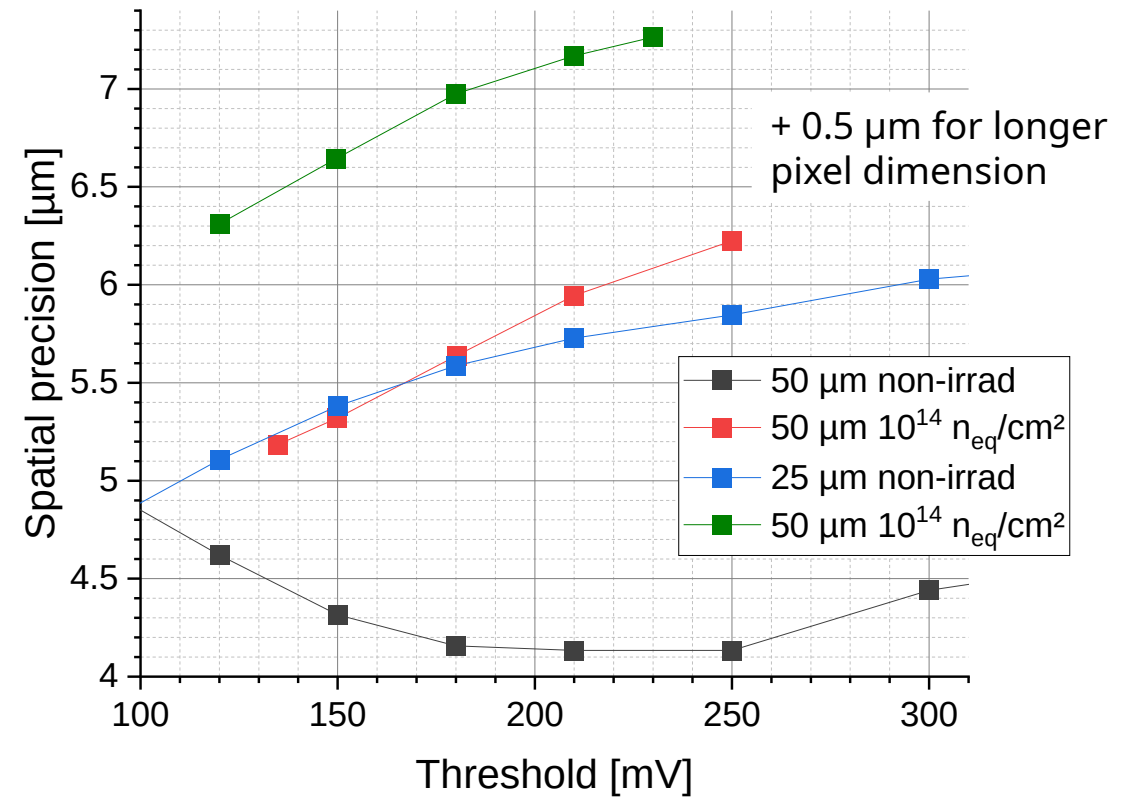


Broadest distribution of cluster shapes
 ⇒ Most different center - of - charge.
 ⇒ Best spatial precision.

Detection efficiency MIMOSIS-2.1 p-stop 50 μm



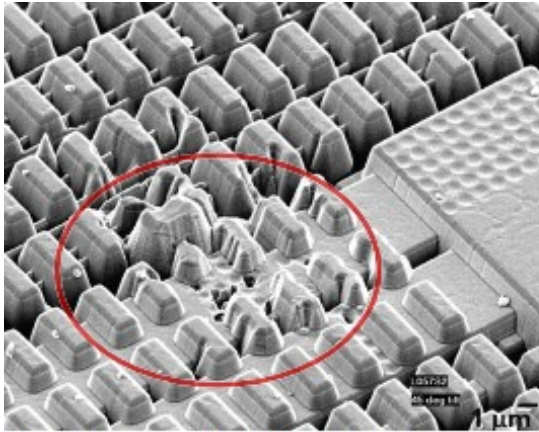
Spat. precision MIMOSIS-2.1 p-stop 25 μm vs. 50 μm



P-stop 50 μm matches rad. tolerance of P-stop 25 μm (not shown).
 P-stop 50 μm keeps its advantages in terms of spat. precision after $10^{14} n_{eq}/\text{cm}^2$

Initial worry: Single-Event Latch up

- Ions create meta-stable short circuit in the ASIC.
- Must power cycle to avoid device burn out.

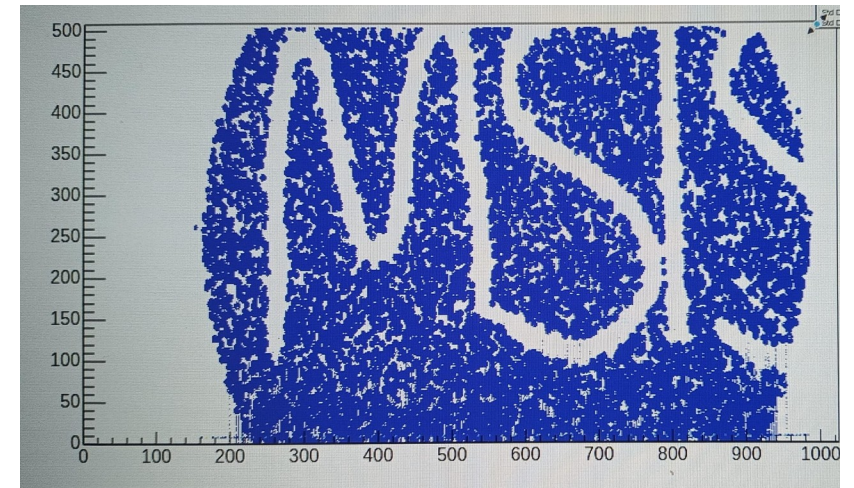
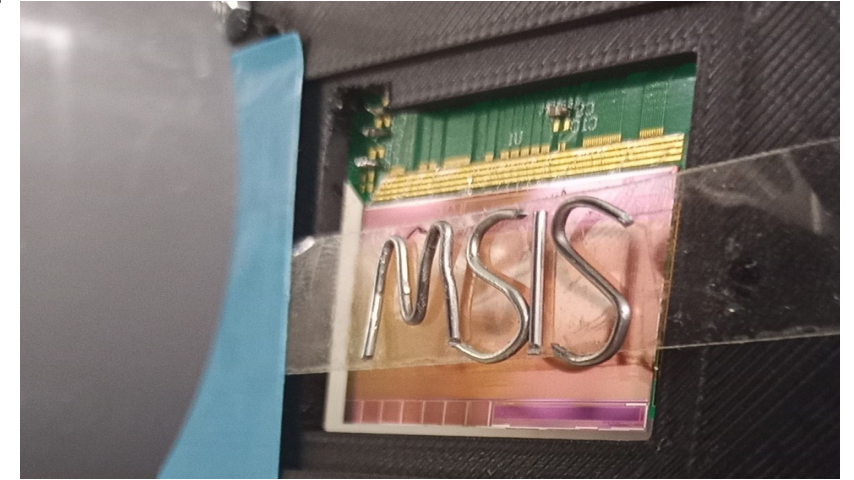


Latch-up in ULTIMATE sensor
G. Contin, JINST 11 C12068 (2016)

Test of MIMOSIS with ~5 AMeV heavy ions at GSI:

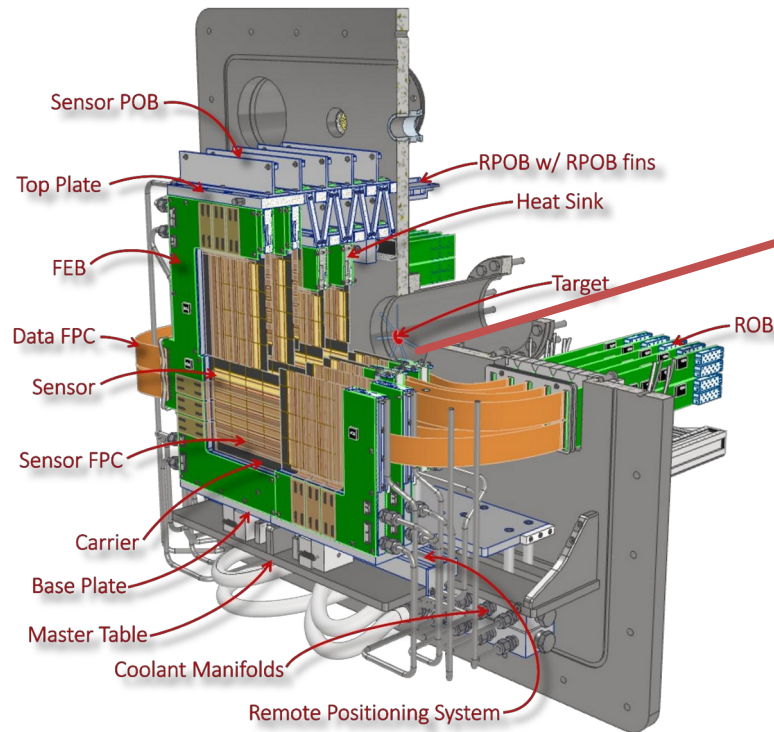
- No latch-ups to LET (dE/dx) > 35 MeV cm² / mg.
- No destruction after >100 MHz/cm² pulses for >1 ms.
- Sensor resumes operation if exposed to ~20 MeV cm²/mg.

Work in progress

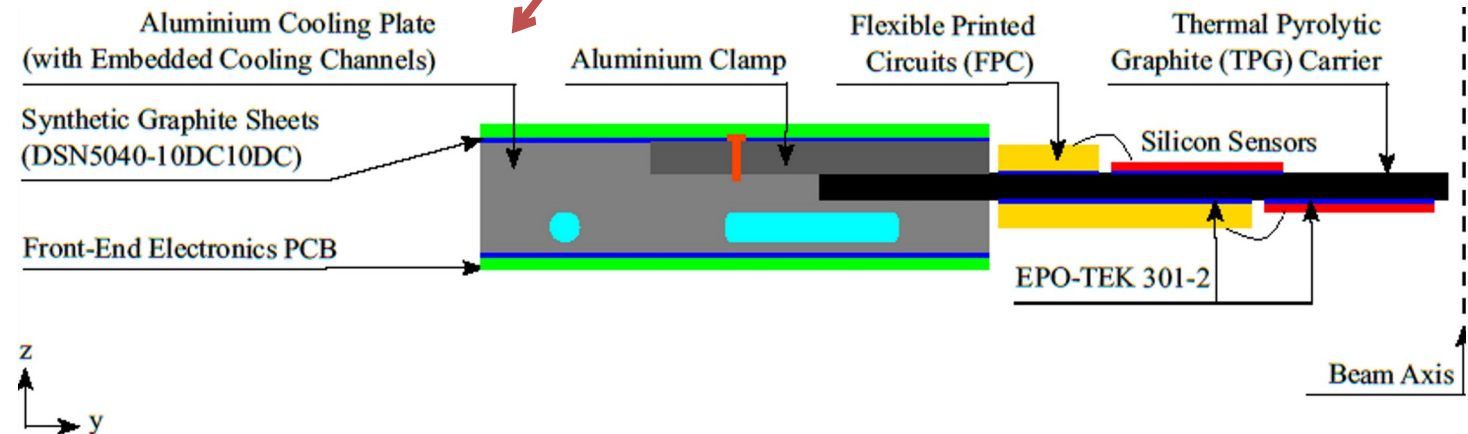
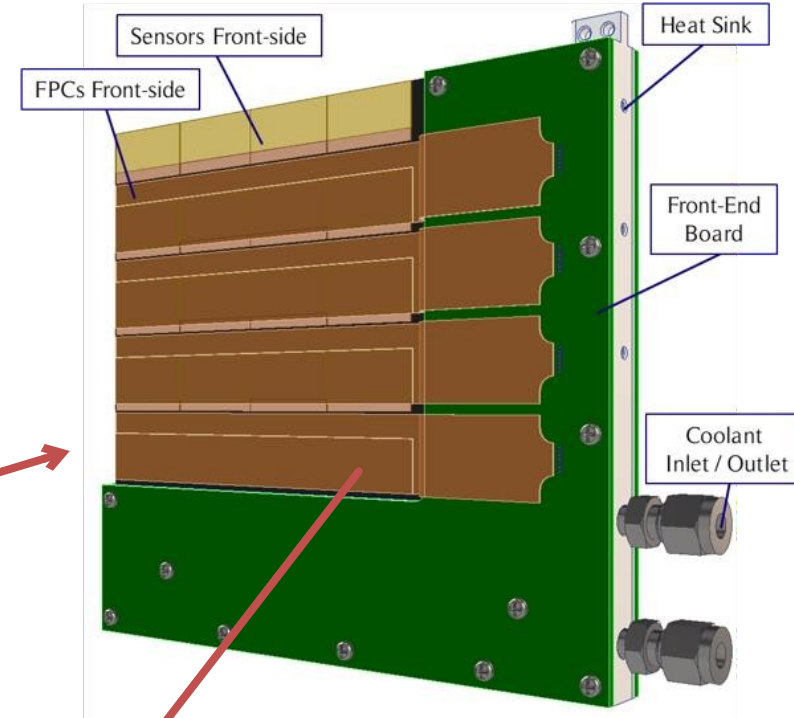


Four planar tracking stations

- ~300 CMOS MAPS
- 5 - 20 cm downstream
- Placed inside Vacuum
- 1Tm Magnetic field
- 0.3 - 0.5 % X_0

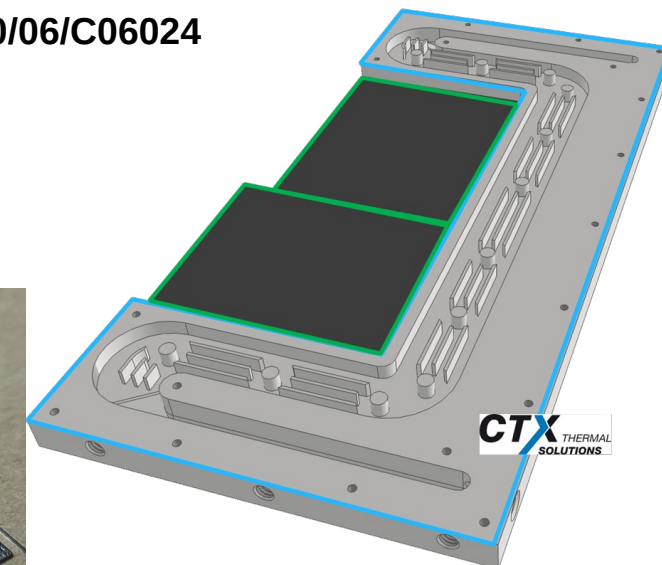
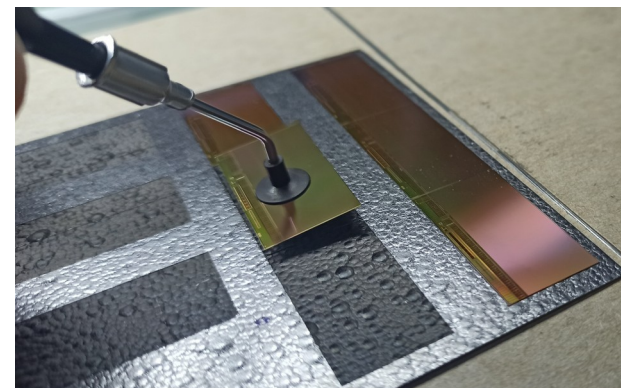


Credits: F. Matejcek



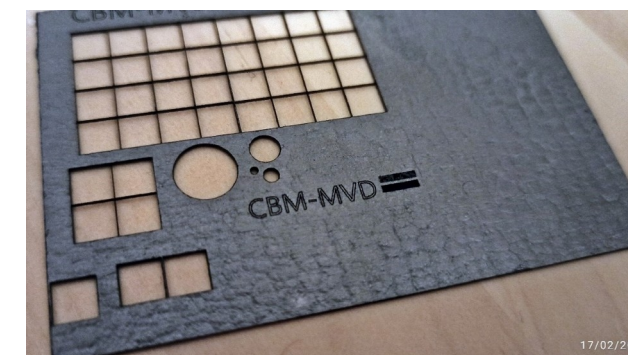
- **Cooling:**
 - Heat conduction inside geometrical acceptance
 - Glycol/water based active cooling outside
 - Using **Thermal Pyrolytic Graphite (TPG)** Carrier
 - Mechanically stable
 - Low material budget ($< 0.2\% X_0$)
 - Highly thermally conductive
 - Large ($\sim 150 \times 150 \text{ mm}^2$)
 - Laser cutting
- **Double-sided Integration:**
 - Integration (double-sided) **TPG sheets** (250 μm and 380 μm)
- **Probe testing at IKF – inspired by ALPIDE**
 - Quality assurance (QA) of sensors
 - **Automatic test procedure** for monitoring: analog, digital, biasing currents, threshold measurement, etc...
 - **Yield: $\sim 55\%$ (First measurements)** → main issue is powering

Ref: 10.1088/1748-0221/20/06/C06024



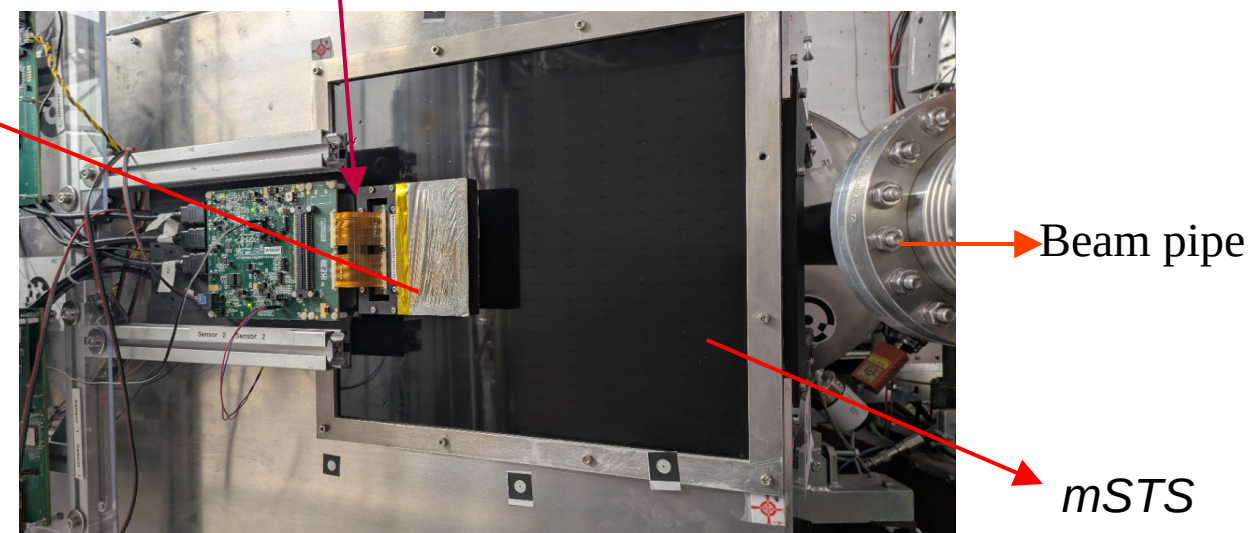
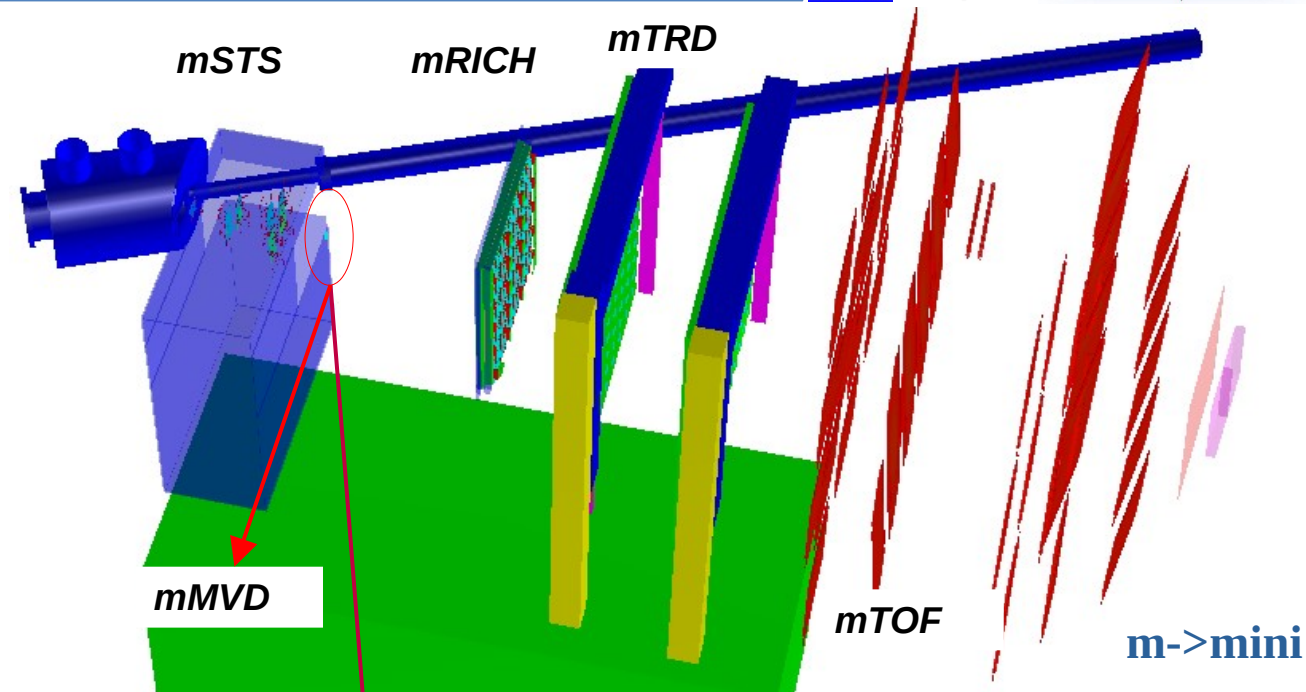
Passive, conductive cooling

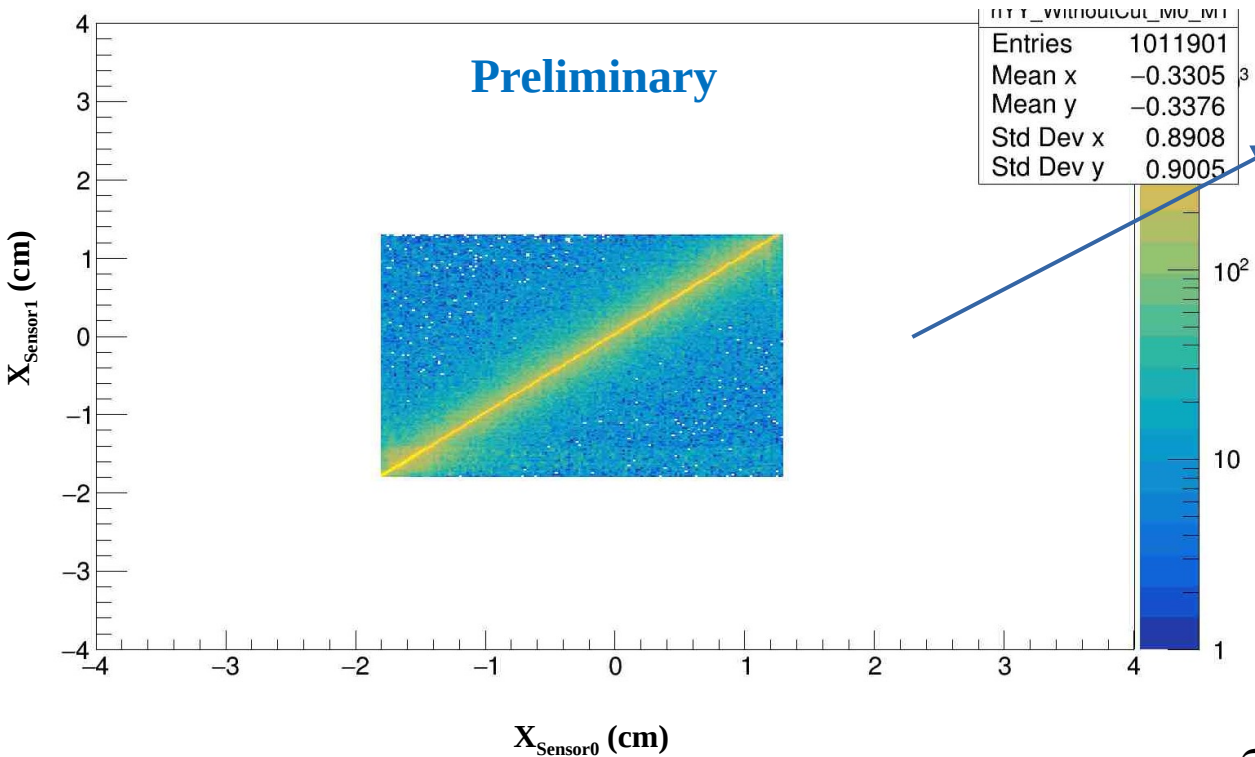
Active, liquid cooling



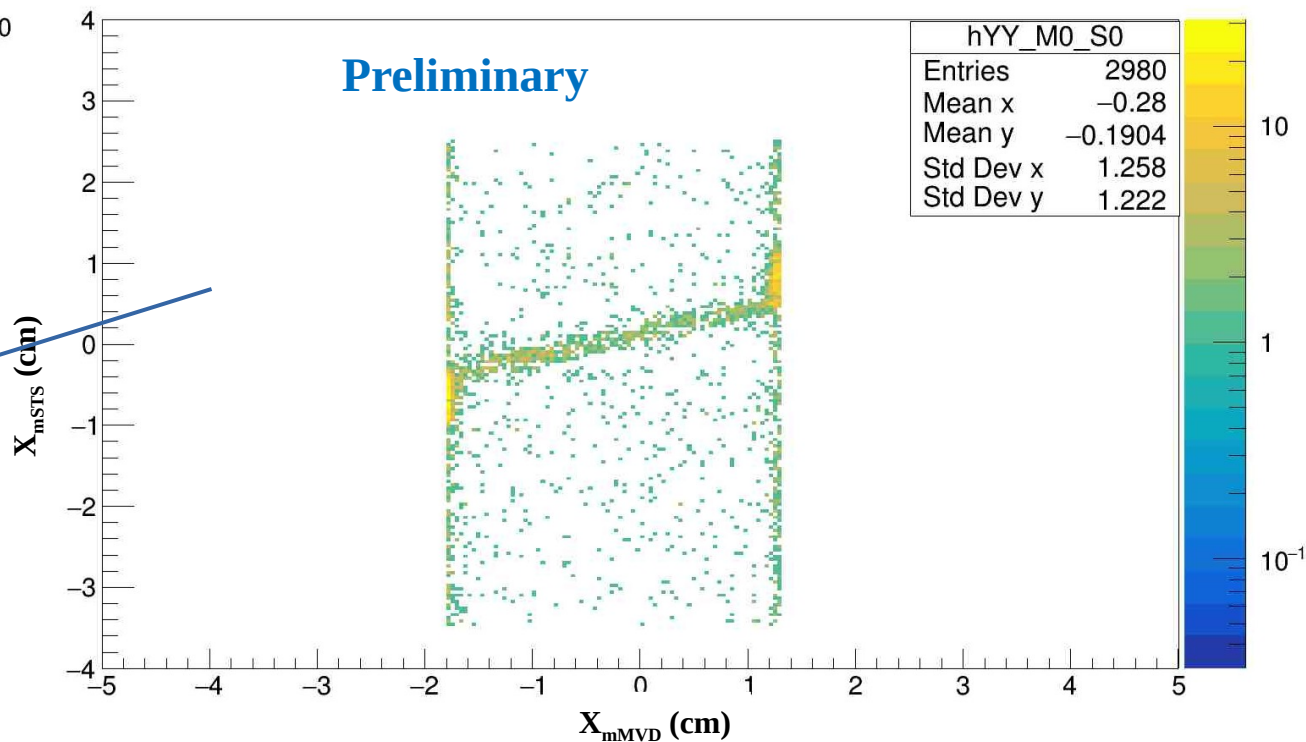
17/02/2023

- **System demonstrator** of CBM in real beam conditions
- **Demonstrate triggerless, free-streaming readout** at high rates
- **Commission & integrate** sub-detectors
- **mMVD**
 - consists of **2 MIMOSIS-2.1 sensors**
 - first time tested in mCBM experiment together others (STS...)
- **Goal:**
 - Test and validate readout
 - Test Synchronisation with others
 - Spa. correlation amongst both sensors
 - Spa. correlation between mMVD and mSTS





Spatial Correlation between two MIMOSIS sensors



Spatial Correlation between mMVD and mSTS

Successful operation of MIMOSIS sensors in CBM-like environment

- free streaming DAQ, Self-triggered common readout

- ✓ **MVD role & specs:** four planar stations (~ 300 MAPS) in vacuum
 - target $\sigma \approx 5 \mu\text{m}$, $0.3\text{--}0.5 \%$ X_0/layer
- ✓ **Performance (MIMOSIS-2.1 focus): $50 \mu\text{m}$ p-stop** gives the best overall performance
 - efficiency $> 99 \%$ with **marginal dark rate**, spatial resolution around $5\text{--}6 \mu\text{m}$
 - even after irradiation (up to $5 \text{MRad} + 10^{14} \text{n}_{\text{eq}} \text{cm}^{-2}$)
 - Also provide higher operational margin
- ✓ **SEE robustness: no latch-up** observed for $\text{LET} > 35 \text{MeV.cm}^2 \text{mg}^{-1}$ meets CBM heavy-ion tolerance requirements
- ✓ **Integration status:** double-sided modules on **TPG carriers** ($\approx 0.2 \%$ X_0), automatic bonding, Probe testing for QA of sensors
 - Mass testing setup ready and running with MIMOSIS-2.1
- ✓ **System demo (mCBM): first mMVD** with two MIMOSIS-2.1 sensors operated with other subsystems
 - **Time synchronization and spatial correlations** demonstrated
- **MIMOSIS-3 submission:** end of 2025

A. Altingun², Julio Andary¹, Benedict Arnoldi-Meadows¹, Ole Artz¹, Jérôme Baudot², Grégory Bertolone², Auguste Besson², Norbert Bialas¹, Roma Bugiel², Gilles Claus², Claude Colledani², Hasan Darwish^{1,2,3}, Michael Deveaux^{1,3,6}, Andrei Dorokhov², Guy Dozière², Ziad El Bitar², Ingo Fröhlich^{1,3}, Mathieu Goffe², Benedikt Gutsche¹, Fabian Hebermehl¹, Abdelkader Himmi², Christine Hu-Guo², Kimmo Jaaskelainen², Oliver Michael Keller⁶, Michal Koziel¹, Ajit Kumar^{1,3}, Franz Matejcek¹, Jan Michel¹, Frédéric Morel², Christian Müntz¹, Hung Pham², Christian Joachim Schmidt³, Stefan Schreiber¹, Matthieu Specht², Dennis Spicker¹, Joachim Stroth^{1,3,4}, Isabelle Valin², Roland Weirich¹, Marc Winter⁵ and Yue Zhao²

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⁵IJCLab, UMR9012 – CNRS / Université Paris-Saclay / Université de Paris, France

⁶Facility for Antiproton and Ion Research in Europe GmbH, Germany



Measurements leading to these results have been performed at the Test Beam Facility at DESY Hamburg (Germany), a member of the Helmholtz Association (HGF)

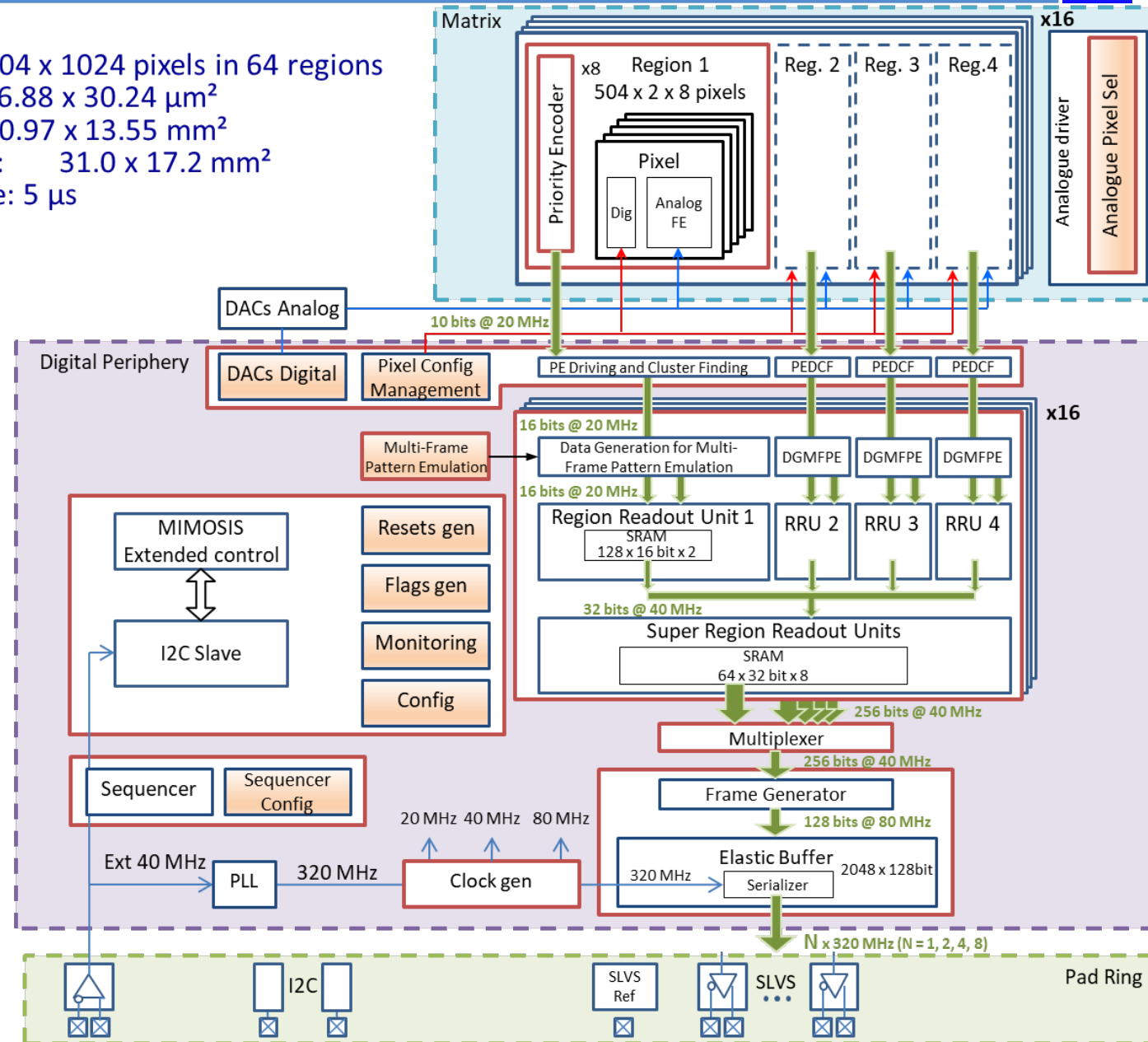
Thank You!

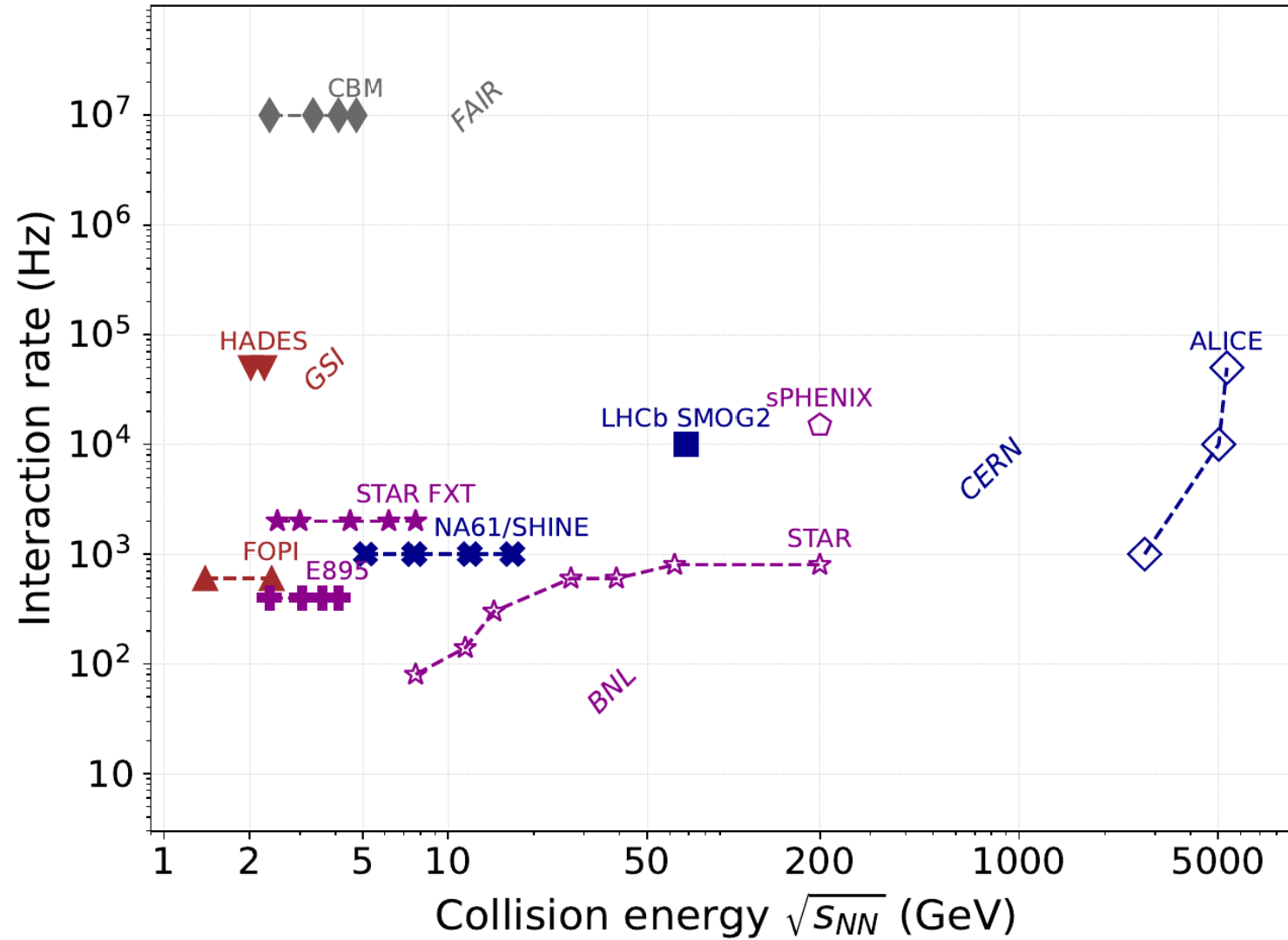
Backup

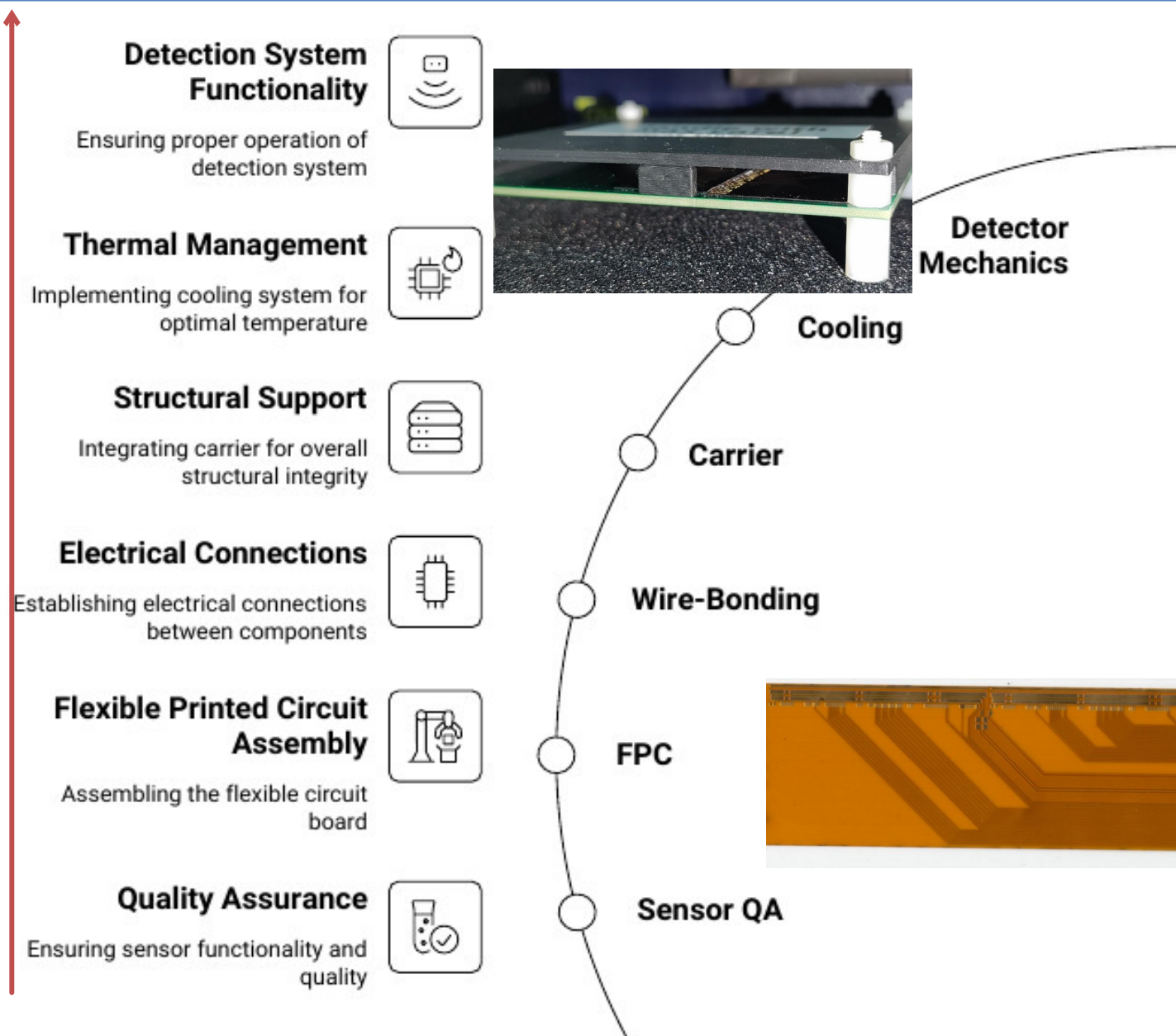
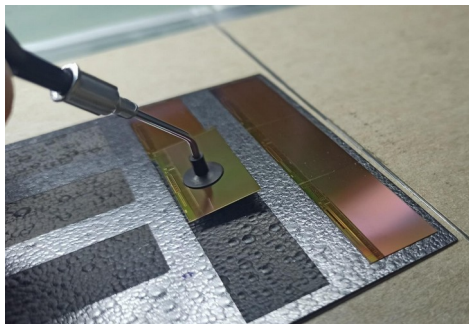
MIMOSIS schematic

- Pixel array: 504 x 1024 pixels in 64 regions
- Pixel pitch: 26.88 x 30.24 μm^2
- Active area: 30.97 x 13.55 mm^2
- Chip dimension: 31.0 x 17.2 mm^2
- Integration time: 5 μs

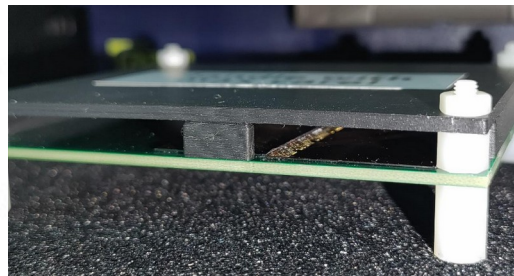
- Pixel array:
 - Analog part of pixel similar to ALPIDE, but 2 versions
 - Digital part of pixel redesigned
 - Priority encoder: same
- Fully reworked digital part



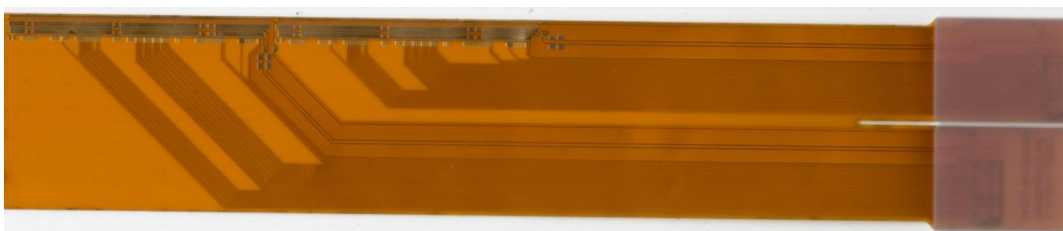




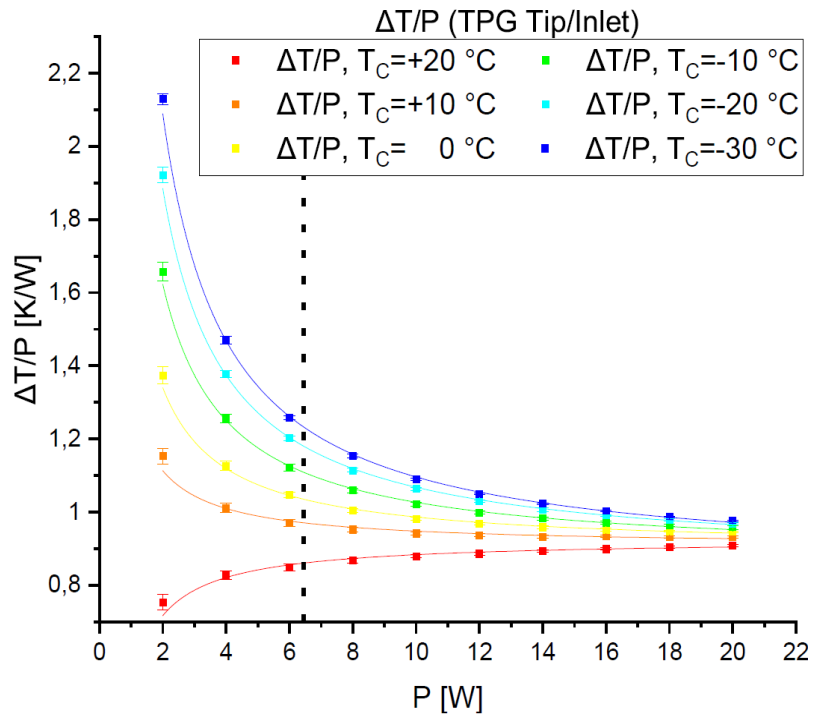
- Detection System Functionality**
Ensuring proper operation of detection system
- Thermal Management**
Implementing cooling system for optimal temperature
- Structural Support**
Integrating carrier for overall structural integrity
- Electrical Connections**
Establishing electrical connections between components
- Flexible Printed Circuit Assembly**
Assembling the flexible circuit board
- Quality Assurance**
Ensuring sensor functionality and quality



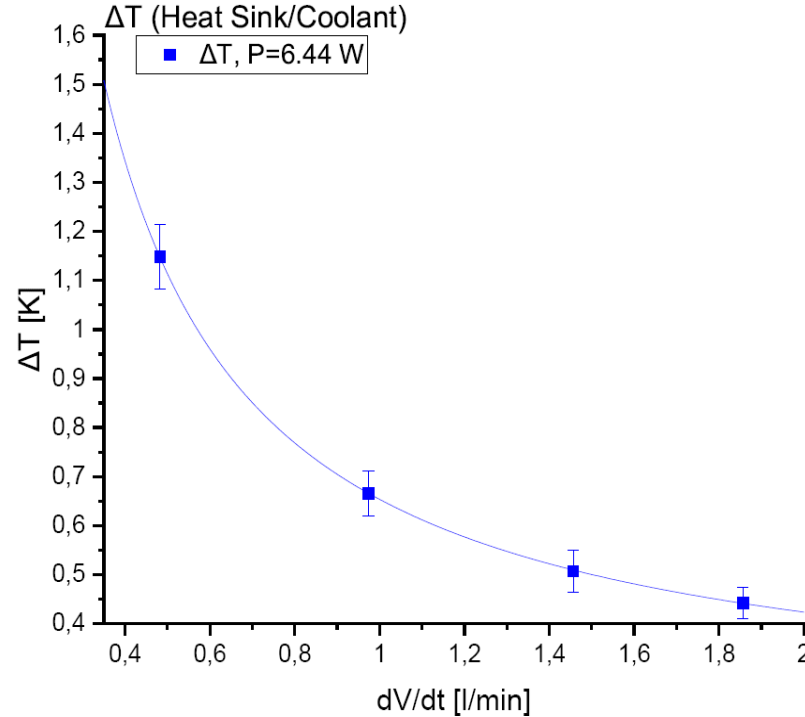
Detector Mechanics



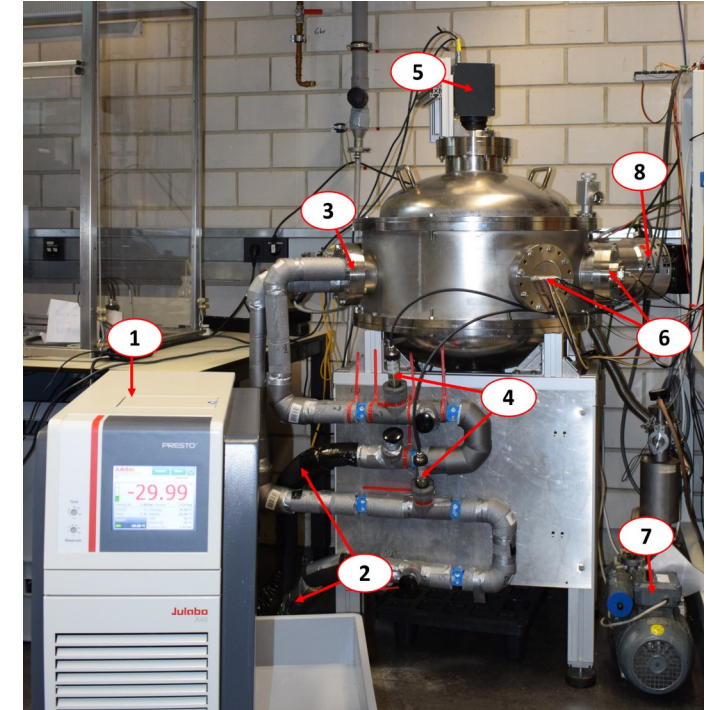
MVD Thermal Performance

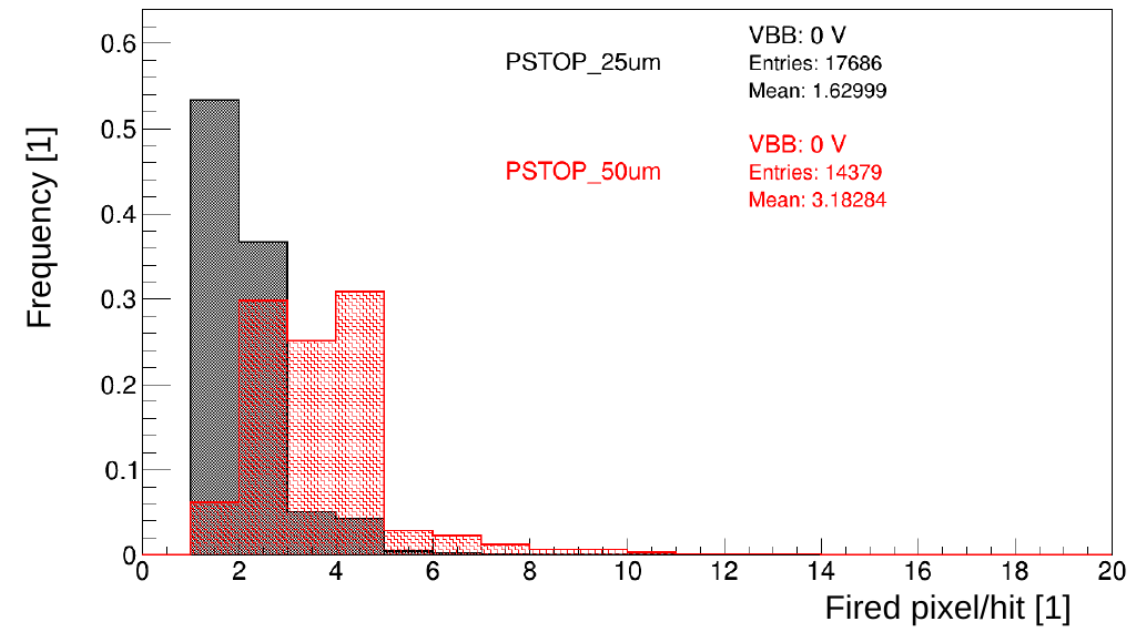
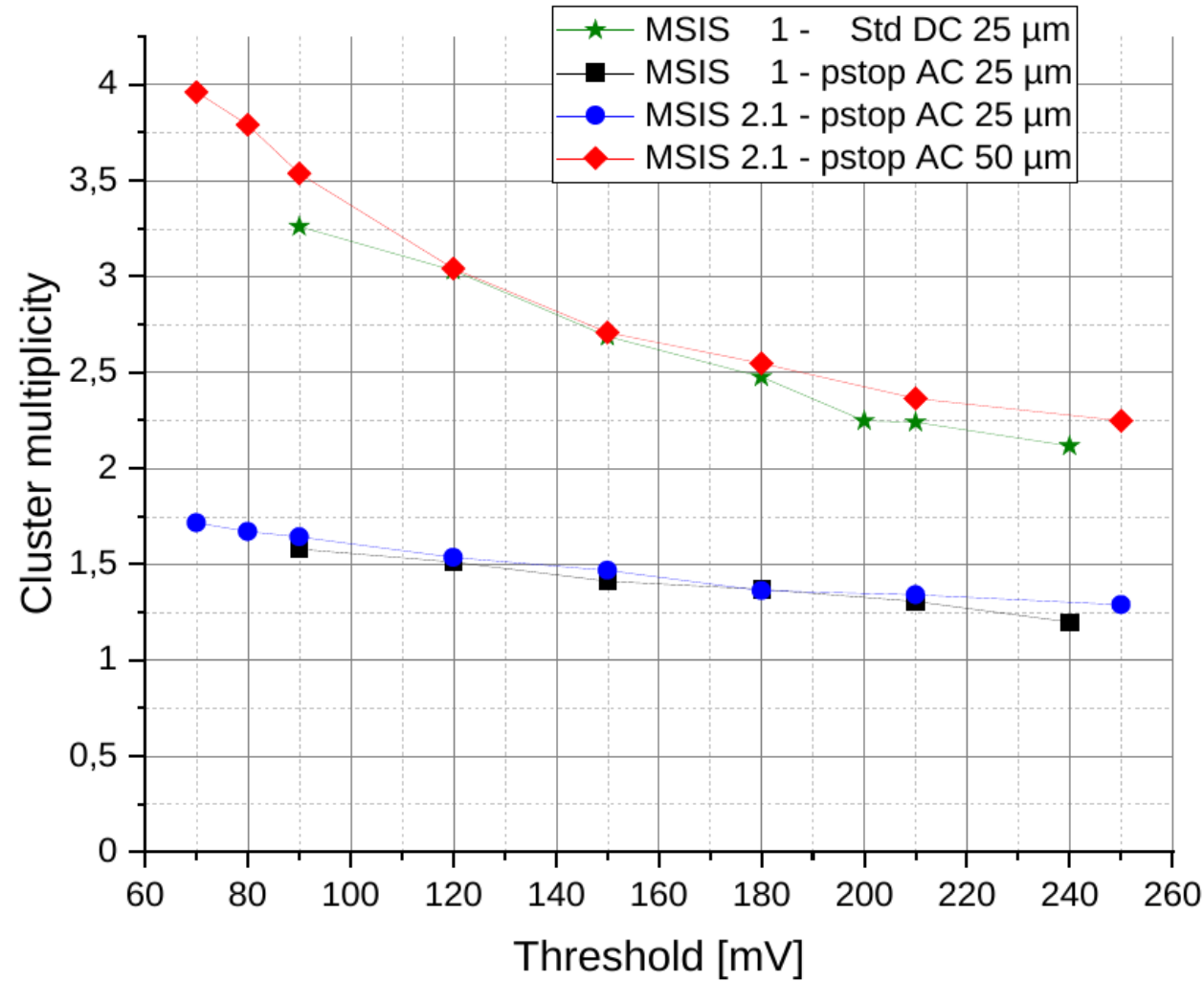


Influence of thermal radiation in testing setup

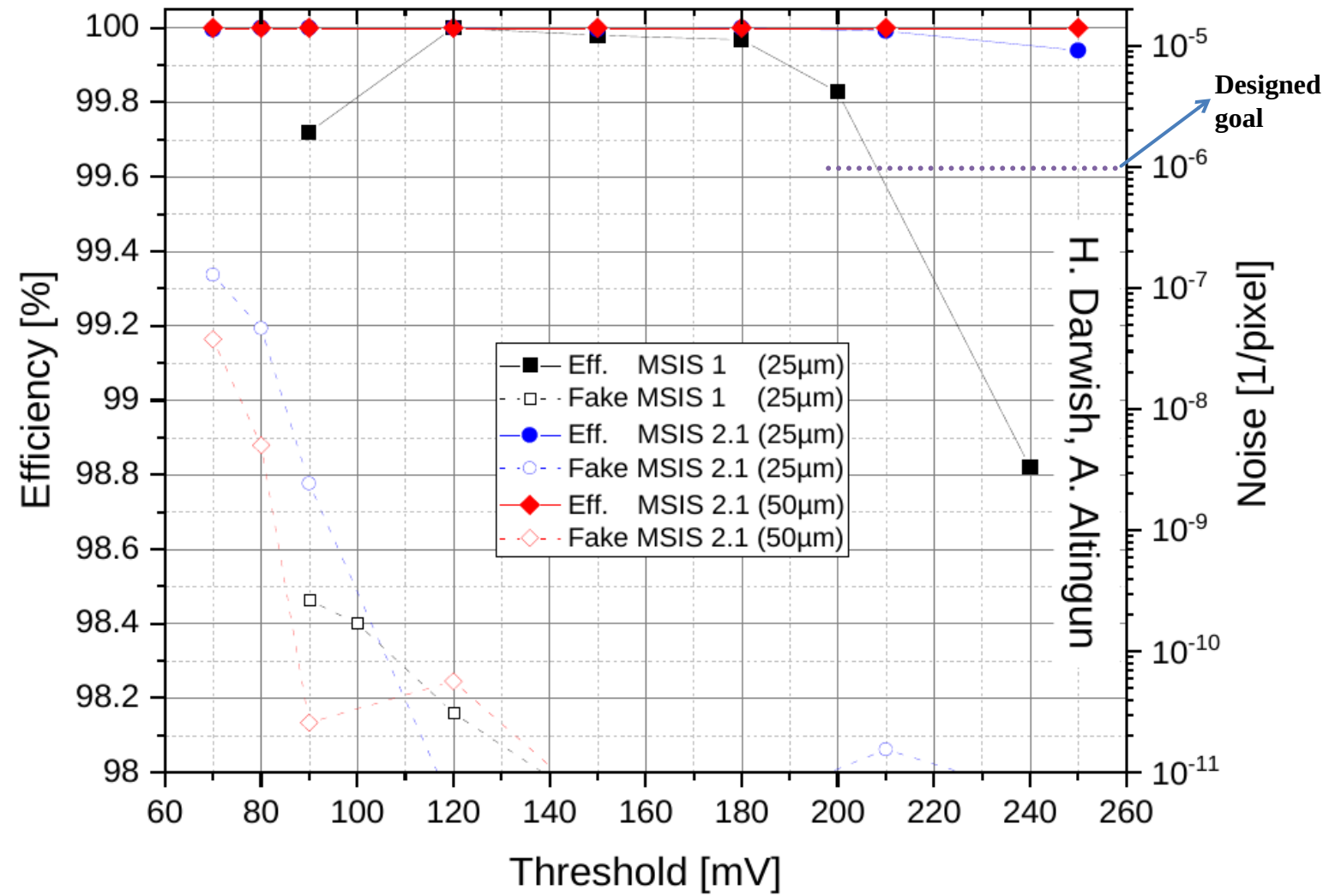


Influence of coolant flow in testing setup





- MIMOSIS-2.1 shows even better efficiency at lower threshold than MIMOSIS-1.
- Large operation range for MIMOSIS-2.1.
- Dark rate below the designed goal (noisy pixels NOT masked)
- Best performance for 50 μ m epitaxial layer with p-stop.



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- High density track environment
 - Forward-boosted cone near target → very high local hit rates
 - Mitigate with 5 μ s frames, on-chip clustering, elastic buffers, multi-link readout
- δ -electrons & beam-induced backgrounds
 - Knock-out e-, halo scraping, back-scatter
- Anisotropic radiation environment
 - Dose/Fluence gradient across acceptance
 - Fully depleted pixels, cool operation
- Stringent material budget (0.3-0.5% X_0 per layer)
 - Minimize multiple scattering for low momentum tracks, reduce secondary production
 - 50-70 μ m sensors, TPG carriers, light FPCs

